



**THE DATASHEET OF  
LT8602IUJ#TRPBF**



## 42V Quad Monolithic Synchronous Step-Down Regulator

### FEATURES

- Flexible Power Supply System Providing Four Outputs with a Wide Input Range
- Two High Voltage Synchronous Buck Regulators:  
3V to 42V Input Voltage Range  
Output Currents Up to 2.5A and 1.5A  
High Efficiency Up to 93%
- Two Low Voltage Synchronous Buck Regulators:  
2.6V to 5.5V Input Voltage Range  
Output Currents Up to 1.8A and 94% Efficiency
- Resistor Programmable and Synchronizable  
250kHz to 2.2MHz Switching Frequency
- Low Ripple Burst Mode® Operation:  
30µA I<sub>Q</sub> at 12V<sub>IN</sub>  
Output Ripple < 15mV
- Programmable Power-On Reset
- Power Good Indicators
- 2-Phase Clock Reduces Input Current Ripple
- Available in Thermally Enhanced 40-Lead QFN (6mm × 6mm) or 48-Lead (7mm × 7mm) LQFP Packages

### APPLICATIONS

- Automotive Systems
- Distributed Supply Regulation
- Industrial Controls and Power Supplies

### DESCRIPTION

The LT®8602 is a quad channel, current mode, monolithic buck switching regulator with a programmable power-on reset. All regulators are synchronized to a single oscillator with an adjustable frequency from 250kHz to 2.2MHz. The LT8602 can be configured for micropower Burst Mode operation or pulse-skipping operation at light load. Micropower operation results in quiescent current of 30µA with all four regulators operating in the application below.

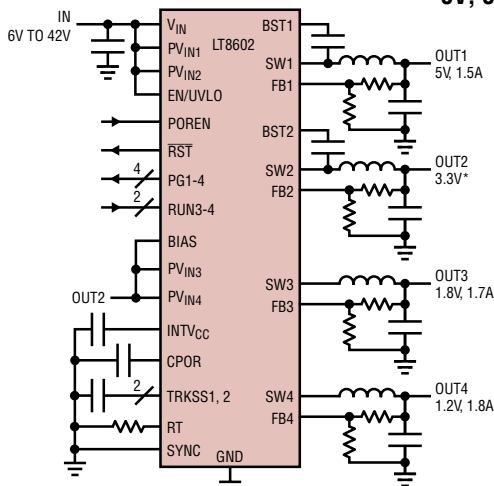
The high voltage channels are synchronous buck regulators that operate from an input of 3V to 42V. The output currents are up to 1.5A (OUT1) and 2.5A (OUT2). The low voltage channels operate from an input of 2.6V to 5.5V. Internal synchronous power switches provide high efficiency with output currents up to 1.8A. The LT8602 uses a 2-phase clock with channels 1 and 3 operating 180° from channels 2 and 4 to reduce input ripple current on both HV and LV inputs. All channels have cycle-by-cycle current limit, providing protection against shorted outputs. Thermal shutdown provides additional protection.

The LT8602 is available in either a 40-lead 6mm × 6mm QFN or a 48-Lead 7mm × 7mm LQFP package.

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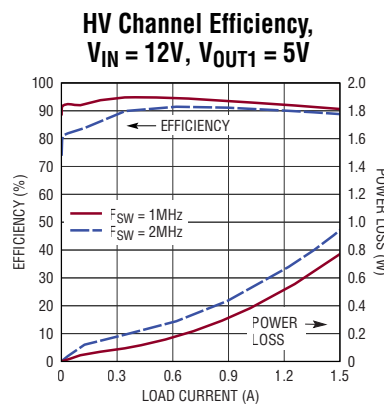
### TYPICAL APPLICATION

5V, 3.3V, 1.8V and 1.2V Step-Down Regulators

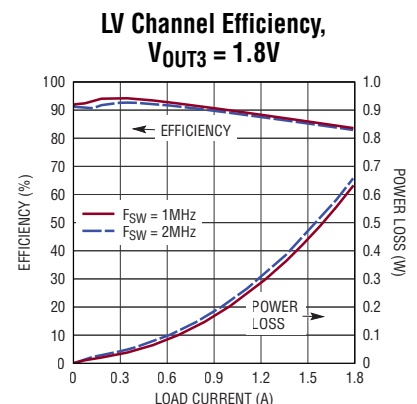


$$*I_{OUT2} = 2.5A - I_{PVIN3} - I_{PVIN4}$$

8602 TA01a



8602 TA01b



8602 TA01c



**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating junction temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{IN} = PV_{IN1} = PV_{IN2} = 12\text{V}$ ,  $EN/UVLO = 3\text{V}$ ,  $PV_{IN3} = PV_{IN4} = 3.3\text{V}$  unless otherwise noted. (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Minimum Operating Voltage		●		2.7	3	V
Minimum Operating Voltage, to Start		●		3.1	3.5	V
$V_{IN}$ Quiescent Current, Shutdown	$EN/UVLO = 0.4\text{V}$			0.1	1	$\mu\text{A}$
$V_{IN}$ Quiescent Current, Operating	No Load (Note 4) 100 $\mu\text{A}$ on $V_{OUT2}$ (Note 4)			30 70		$\mu\text{A}$ $\mu\text{A}$
EN/UVLO Threshold	EN/UVLO Rising		1.15	1.2	1.25	V
EN/UVLO Hysteresis				50		mV
EN/UVLO Input Current	EN/UVLO = 2V		-40		40	nA

**Oscillator**

Switching Frequency	$R_T = 28.9\text{k}$ $R_T = 254\text{k}$	●	1.8 0.225	2 0.25	2.2 0.275	MHz MHz
SYNC Input Frequency Range		●	0.25		2.2	MHz
SYNC Input Voltage Low		●			0.3	V
SYNC Input Voltage High		●	1.2			V
SYNC Input Current			-100		100	nA

**Channel 1**

Feedback Voltage		●	0.988	1	1.012	V
FB Voltage Line Regulation	$V_{IN} = 3\text{V to } 42\text{V}$			0.002	0.01	%/V
Input Current FB1		●	-100		100	nA
SW1 Peak Current Limit	$V_{IN} = PV_{IN1} = 6\text{V}$		2.3	2.7	3.0	A
SW1 Leakage Current				0.1	1	$\mu\text{A}$
SW1 Top On Resistance	$I_{SW1} = 1\text{A}$			240		$\text{m}\Omega$
SW1 Bottom On Resistance	$I_{SW1} = 1\text{A}$			170		$\text{m}\Omega$
Lower FB1 Power Good Threshold	Percentage of $V_{FB1}$	●	89	92	95	%
Upper FB1 Power Good Threshold	Percentage of $V_{FB1}$	●	105	108	111	%
PG1 Output Voltage Low	$I_{PG1} = -100\mu\text{A}$	●		0.1	0.2	V
PG1 Leakage Current	PG1 = 5V, FB1 = 1V	●			30	$\mu\text{A}$
TRKSS1 Pull-Up Current	SS1 = 0.2V		1.5	2.4	3.1	$\mu\text{A}$
Minimum Switch-On Time	$I_{SW1} = 1\text{A}$			60		ns
Minimum Switch-Off Time	$I_{SW1} = 1\text{A}$			70		ns

## ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating junction temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{IN} = PV_{IN1} = PV_{IN2} = 12\text{V}$ ,  $EN/UVLO = 3\text{V}$ ,  $PV_{IN3} = PV_{IN4} = 3.3\text{V}$  unless otherwise noted. (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
<b>Channel 2</b>						
Feedback Voltage		●	0.988	1	1.012	V
FB Voltage Line Regulation	$V_{IN} = 3\text{V to } 42\text{V}$			0.002	0.01	%/V
Input Current FB2		●	-100		100	nA
SW2 Peak Current Limit	$V_{IN} = PV_{IN2} = 6\text{V}$		3.5	4.0	4.5	A
SW2 Leakage Current				0.1	1	$\mu\text{A}$
SW2 Top On Resistance	$I_{SW2} = 1\text{A}$			150		$\text{m}\Omega$
SW2 Bottom On Resistance	$I_{SW2} = 1\text{A}$			100		$\text{m}\Omega$
Lower FB2 Power Good Threshold	Percentage of $V_{FB2}$	●	89	92	95	%
Upper FB2 Power Good Threshold	Percentage of $V_{FB2}$	●	105	108	111	%
PG2 Output Voltage Low	$I_{PG2} = -100\mu\text{A}$	●		0.1	0.2	V
PG2 Leakage Current	$PG2 = 5\text{V}$ , $FB2 = 1\text{V}$	●			30	$\mu\text{A}$
TRKSS2 Pull-Up Current	$SS2 = 0.2\text{V}$		1.5	2.4	3.1	$\mu\text{A}$
Minimum Switch-On Time	$I_{SW2} = 2\text{A}$			60		ns
Minimum Switch-Off Time	$I_{SW2} = 2\text{A}$			70		ns
<b>Channel 3</b>						
Operating Voltage		●	2.6		5.5	V
Feedback Voltage		●	790	800	810	mV
FB Voltage Line Regulation	$V_{IN} = 3\text{V to } 42\text{V}$			0.002	0.01	%/V
Input Current FB3		●	-100		100	nA
SW3 Average Current Limit			1.8	3.1	3.5	A
SW3 Leakage	$PV_{IN3} = 5.5\text{V}$			0.1	1	$\mu\text{A}$
SW3 PMOS On Resistance	$I_{SW3} = 1\text{A}$			150		$\text{m}\Omega$
SW3 NMOS On Resistance	$I_{SW3} = 1\text{A}$			120		$\text{m}\Omega$
Lower FB3 Power Good Threshold	Percentage of $V_{FB3}$	●	89	92	95	%
Upper FB3 Power Good Threshold	Percentage of $V_{FB3}$	●	105	108	111	%
PG3 Output Voltage Low	$I_{PG3} = -100\mu\text{A}$	●		0.1	0.2	V
PG3 Leakage Current	$PG3 = 5\text{V}$ , $FB3 = 0.8\text{V}$	●			30	$\mu\text{A}$
RUN3 Threshold Voltage		●	0.695	0.72	0.75	V
RUN3 Input Current	$RUN3 = 3.3\text{V}$	●	-100		100	nA
Soft-Start Time		●	0.7	1	1.3	ms
Minimum Switch-On Time	$I_{SW3} = 1\text{A}$			70		ns
Minimum Switch-Off Time	$I_{SW3} = 1\text{A}$			70		ns
$PV_{IN3}$ UVLO				2.35	2.6	V

**ELECTRICAL CHARACTERISTICS** The ● denotes the specifications which apply over the full operating junction temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{IN} = PV_{IN1} = PV_{IN2} = 12\text{V}$ ,  $EN/UVLO = 3\text{V}$ ,  $PV_{IN3} = PV_{IN4} = 3.3\text{V}$  unless otherwise noted. (Note 2)

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
<b>Channel 4</b>						
Operating Voltage		●	2.6		5.5	V
Feedback Voltage		●	790	800	810	mV
FB Voltage Line Regulation	$V_{IN} = 3\text{V to } 42\text{V}$			0.002	0.01	%/V
Input Current FB4		●	-100		100	nA
SW4 Average Current Limit			1.8	3.1	3.5	A
SW4 Leakage	$PV_{IN4} = 5.5\text{V}$			0.1	1	$\mu\text{A}$
SW4 PMOS On Resistance	$I_{SW4} = 1\text{A}$			150		$\text{m}\Omega$
SW4 NMOS On Resistance	$I_{SW4} = 1\text{A}$			120		$\text{m}\Omega$
Lower FB4 Power Good Threshold	Percentage of $V_{FB4}$	●	89	92	95	%
Upper FB4 Power Good Threshold	Percentage of $V_{FB4}$	●	105	108	111	%
PG4 Output Voltage Low	$I_{PG4} = -100\mu\text{A}$	●		0.1	0.2	V
PG4 Leakage Current	$PG4 = 5\text{V}, FB4 = 0.8\text{V}$	●			30	$\mu\text{A}$
RUN4 Threshold Voltage		●	0.695	0.72	0.75	V
RUN4 Input Current	$RUN4 = 3.3\text{V}$	●	-100		100	nA
Soft-Start Time		●	0.7	1	1.3	ms
Minimum Switch-On Time	$I_{SW4} = 1\text{A}$			70		ns
Minimum Switch-Off Time	$I_{SW1} = 1\text{A}$			70		ns
$PV_{IN4}$ UVLO				2.35	2.6	V
<b>Power-On Reset</b>						
CPOR Pull-Up Current	$CPOR = 0\text{V}$			2		$\mu\text{A}$
POR Delay Time	$CPOR = 1000\text{pF}$		31	35.2	39.4	ms
$\overline{\text{RST}}$ Output Voltage Low	$I_{\overline{\text{RST}}} = -100\mu\text{A}$	●		0.1	0.2	V
$\overline{\text{RST}}$ Pull-Up Current	POR Timed Out, $\overline{\text{RST}} = 0\text{V}$			20		$\mu\text{A}$
$\overline{\text{RST}}$ Leakage Current	$\overline{\text{RST}} = 6\text{V}, EN/UVLO = 0\text{V}$		-40		40	nA
POREN Threshold		●	1.15	1.2	1.25	V
POREN Pull-Up Current	$POREN = 0\text{V}$		0.8	1.2	1.6	$\mu\text{A}$

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

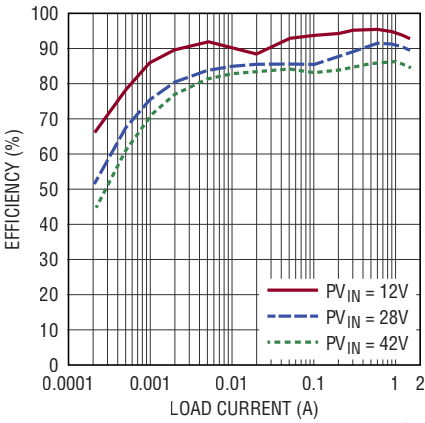
**Note 2:** The LT8602E is guaranteed to meet performance specifications from  $0^\circ\text{C}$  to  $125^\circ\text{C}$  junction temperature. Specifications over the  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  operating junction temperature range are assured by design, characterization and correlation with statistical process controls. The LT8602I is guaranteed to meet performance specifications from  $-40^\circ\text{C}$  to  $125^\circ\text{C}$  junction temperature.

**Note 3:** This IC includes overtemperature protection that is intended to protect the device during overload conditions. Junction temperature will exceed  $150^\circ\text{C}$  when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature will reduce lifetime.

**Note 4:** All four channels enabled as shown in the application circuit details of front page application (using the 1MHz component values) found in the Typical Application section.

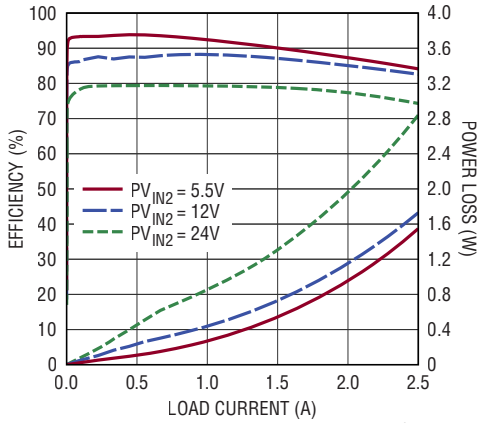
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**Channel 1 Efficiency vs Load**  
 $V_{OUT1} = 8\text{V}$ ,  $F_{SW} = 2\text{MHz}$



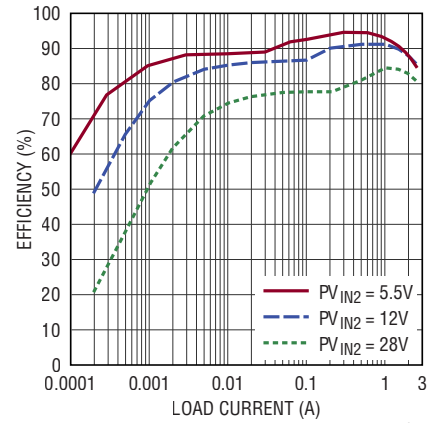
8602 G01

**Channel 2 Efficiency vs Load**  
 $V_{OUT2} = 3.3\text{V}$ ,  $F_{SW} = 2\text{MHz}$



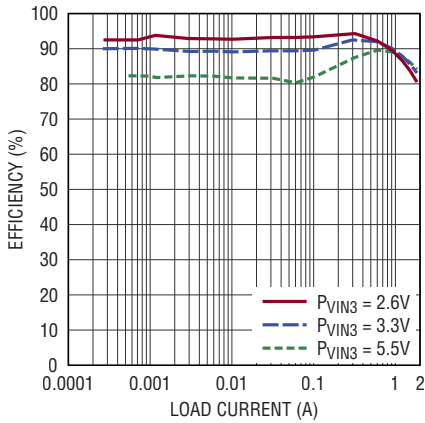
8602 G02

**Channel 2 Efficiency vs Load**  
 $V_{OUT2} = 3.3\text{V}$ ,  $F_{SW} = 1\text{MHz}$



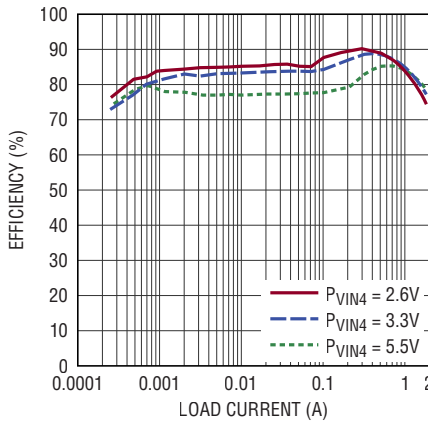
8602 G03

**LV Channel Efficiency vs Load**  
 $V_{OUT3} = 1.8\text{V}$ ,  $F_{SW} = 1\text{MHz}$



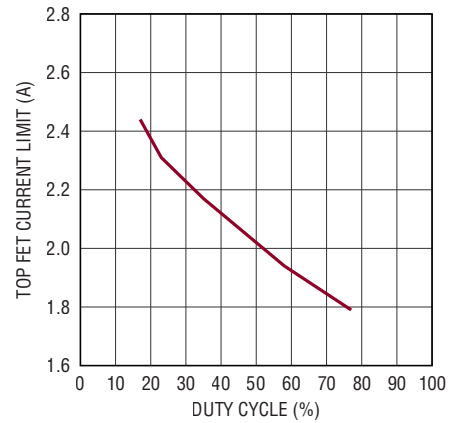
8602 G04

**LV Channel Efficiency vs Load**  
 $V_{OUT4} = 1.2\text{V}$ ,  $F_{SW} = 2\text{MHz}$



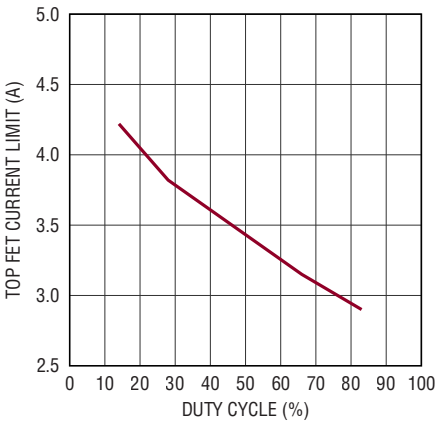
8602 G05

**Channel 1 Peak Current Limit vs Duty Cycle**



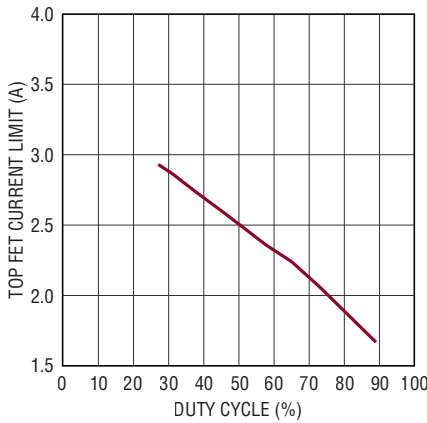
8602 G06

**Channel 2 Peak Current Limit vs Duty Cycle**



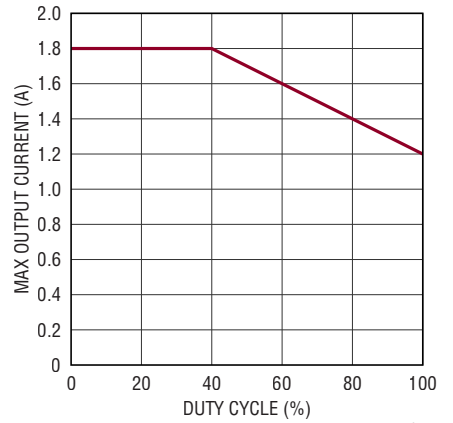
8602 G07

**Channel 3/4 Peak Current Limit vs Duty Cycle**



8602 G08

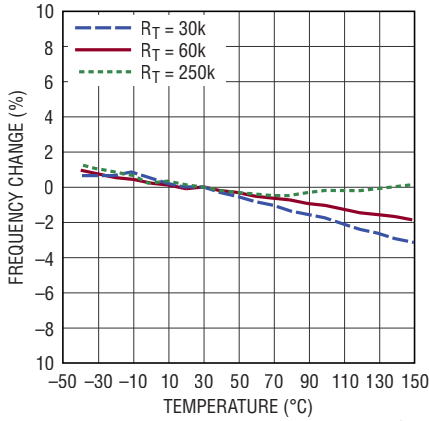
**Channel 3/Channel 4 Maximum Output Current vs Duty Cycle**



8602 G09

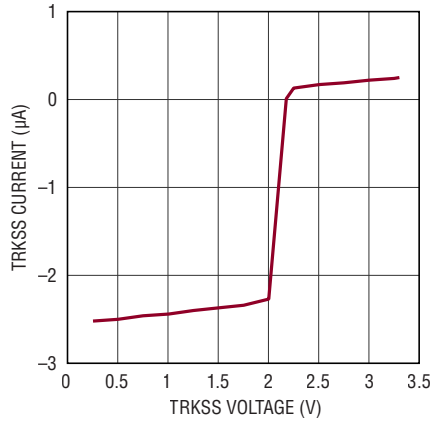
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**Switching Frequency vs Temperature**



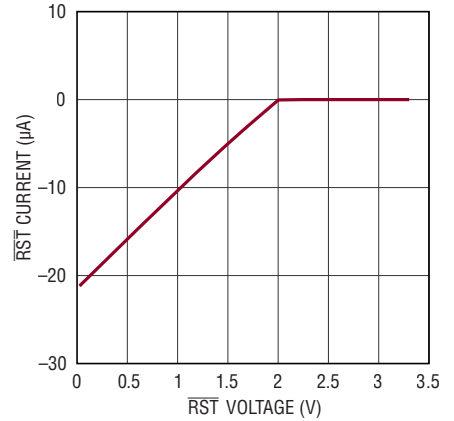
8602 G10

**TRKSS Pull-Up Current vs Voltage**



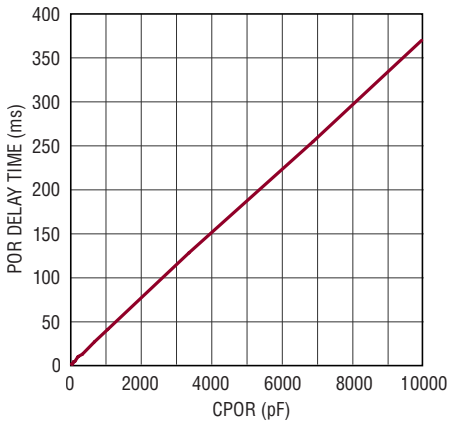
8602 G11

**RST Pull-Up Current vs Voltage**



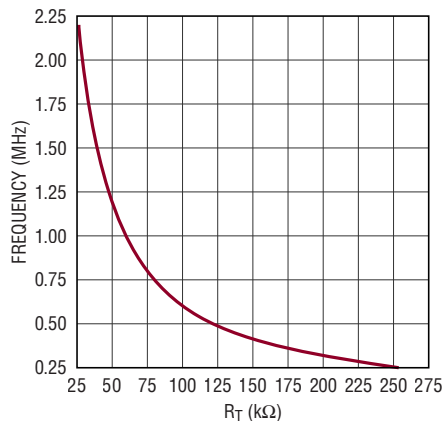
8602 G12

**Power-On Reset Time vs CPOR**



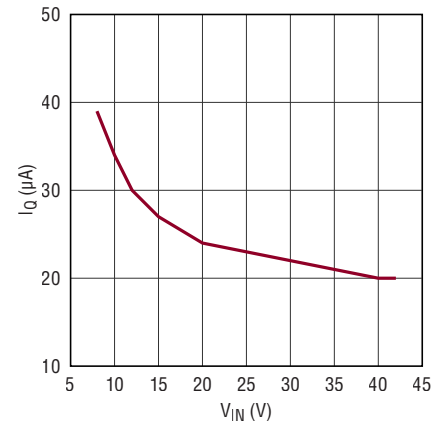
8602 G13

**Switching Frequency vs RT**



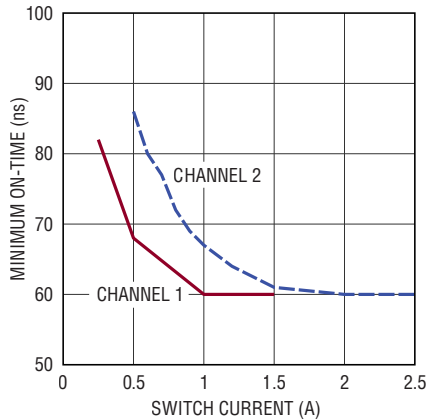
8602 G14

**Quiescent Current vs VIN**



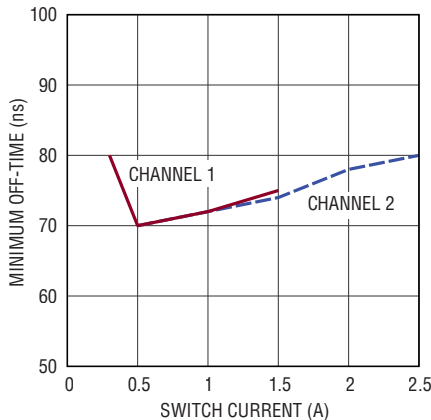
8602 G15

**Minimum On-Time vs ISW**



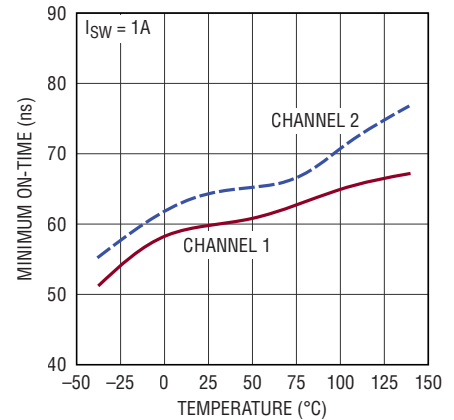
8602 G16

**Minimum Off-Time vs ISW**



8602 G17

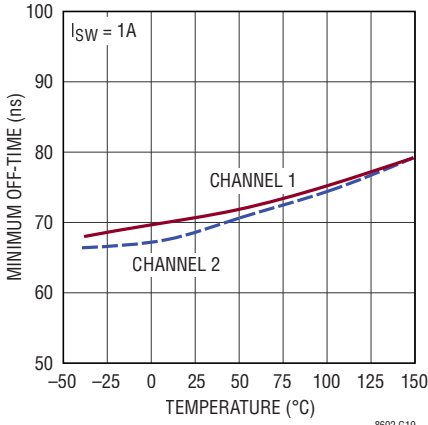
**Minimum On-Time vs Temperature**



8602 G18

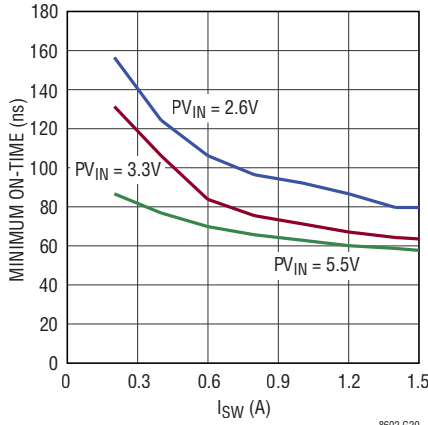
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**Minimum Off-Time vs Temperature**



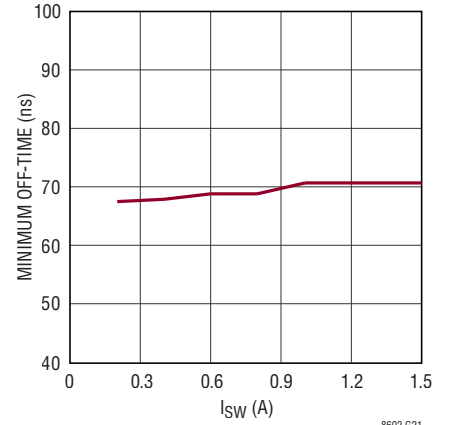
8602 G19

**Channel 3/Channel 4 Minimum On-Time vs  $I_{SW}$**



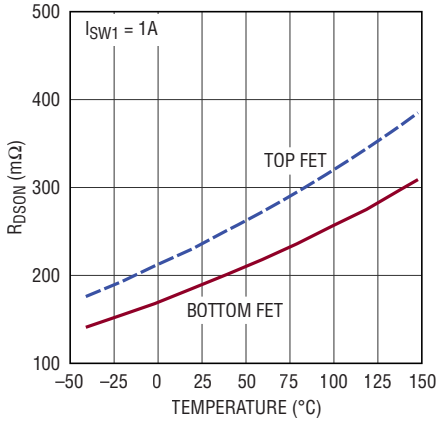
8602 G20

**Channel 3/Channel 4 Minimum Off-Time vs  $I_{SW}$**



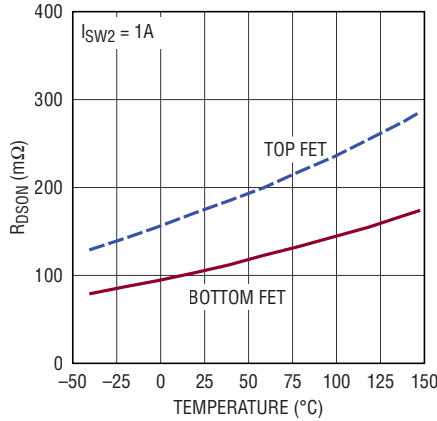
8602 G21

**Channel 1  $R_{DS(on)}$  vs Temperature**



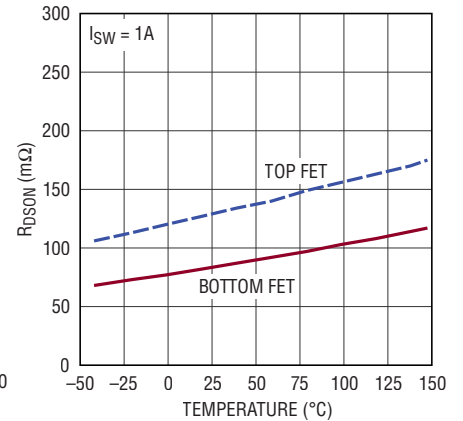
8602 G22

**Channel 2  $R_{DS(on)}$  vs Temperature**



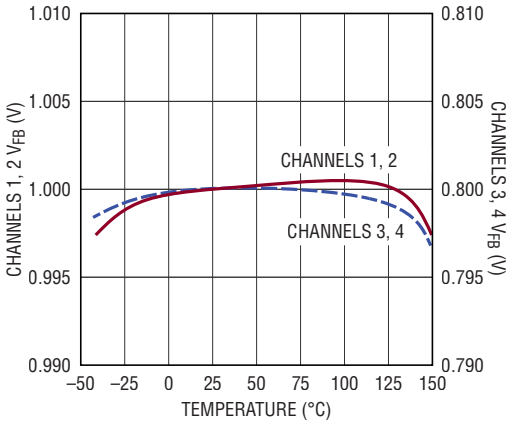
8602 G23

**Channel 3/Channel 4  $R_{DS(on)}$  vs Temperature**



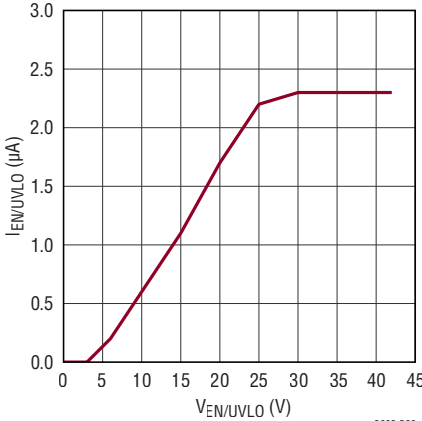
8602 G24

**Feedback Voltage vs Temperature**



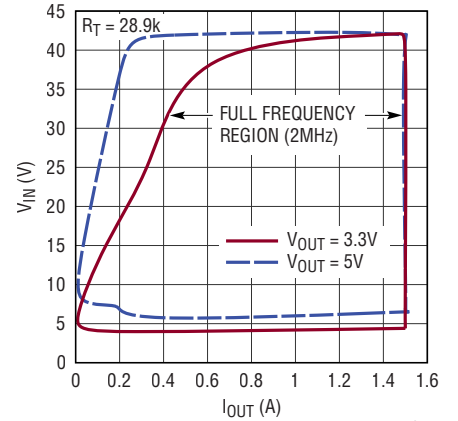
8602 G25

**EN/UVLO Current vs Voltage**



8602 G26

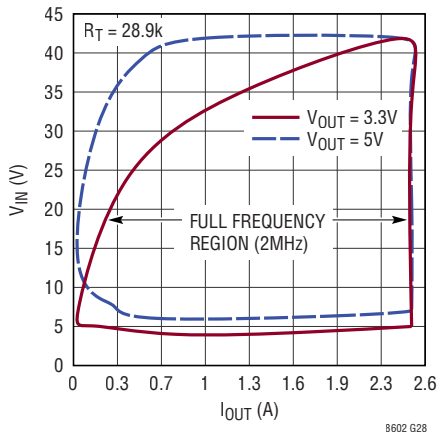
**Channel 1 Full Frequency  $V_{IN}$  vs Load Current**



8602 G27

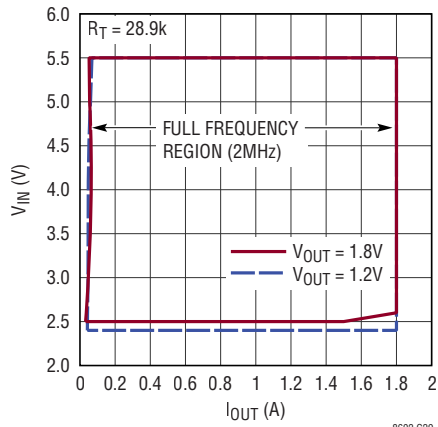
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**Channel 2 Full Frequency  $V_{IN}$  vs Load Current**



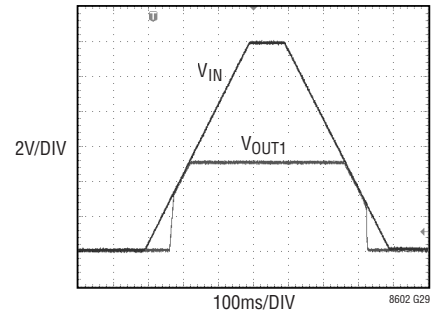
8602 G28

**Channel 3, 4 Full Frequency  $V_{IN}$  vs Load Current**



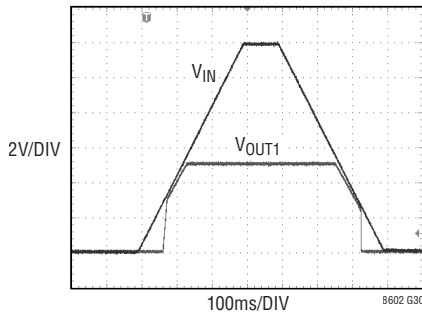
8602 G29

**Channel 1 Start-Up and Dropout,  $R_L = 20\Omega$**



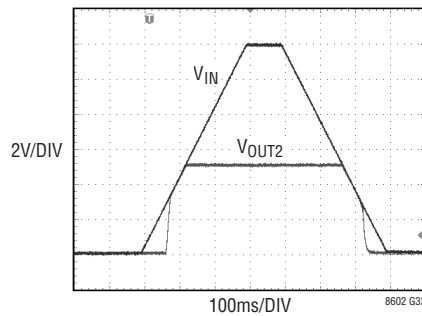
8602 G29

**Channel 1 Start-Up and Dropout,  $R_L = 3.3\Omega$**



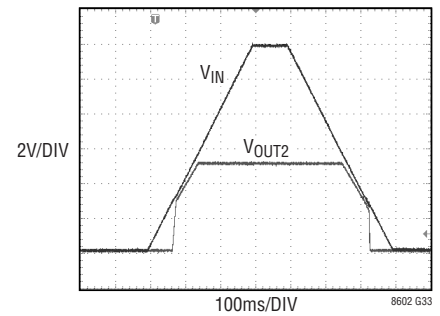
8602 G30

**Channel 2 Start-Up and Dropout,  $R_L = 20\Omega$**



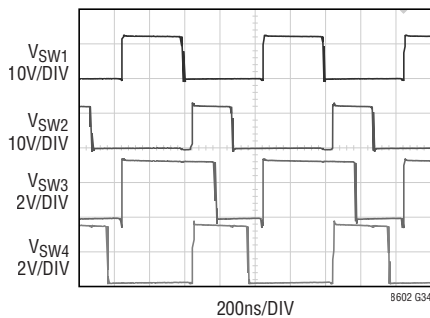
8602 G32

**Channel 2 Start-Up and Dropout,  $R_L = 2\Omega$**



8602 G33

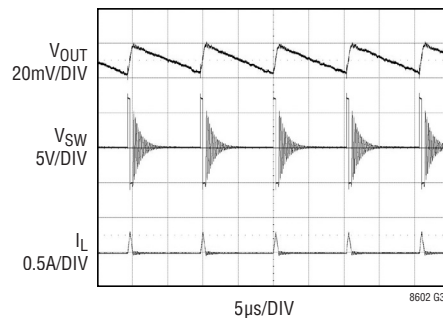
**Full Frequency Waveforms**



8602 G34

$V_{OUT1} = 5\text{V}$   
 $V_{OUT2} = 3.3\text{V}$   
 $V_{OUT3} = 1.8\text{V}$   
 $V_{OUT4} = 1.2\text{V}$

**Light Load Waveforms**



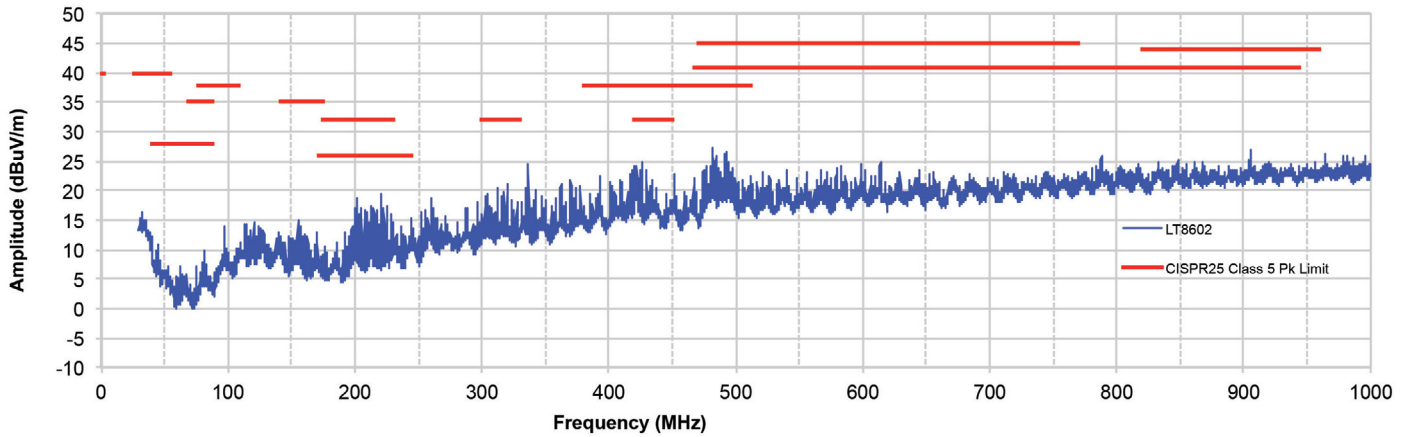
8602 G35

CHANNEL 1  
 $12\text{V}_{IN}$  TO  $5\text{V}_{OUT}$  AT  $10\text{mA}$   
 $V_{SYNC} = 0\text{V}$

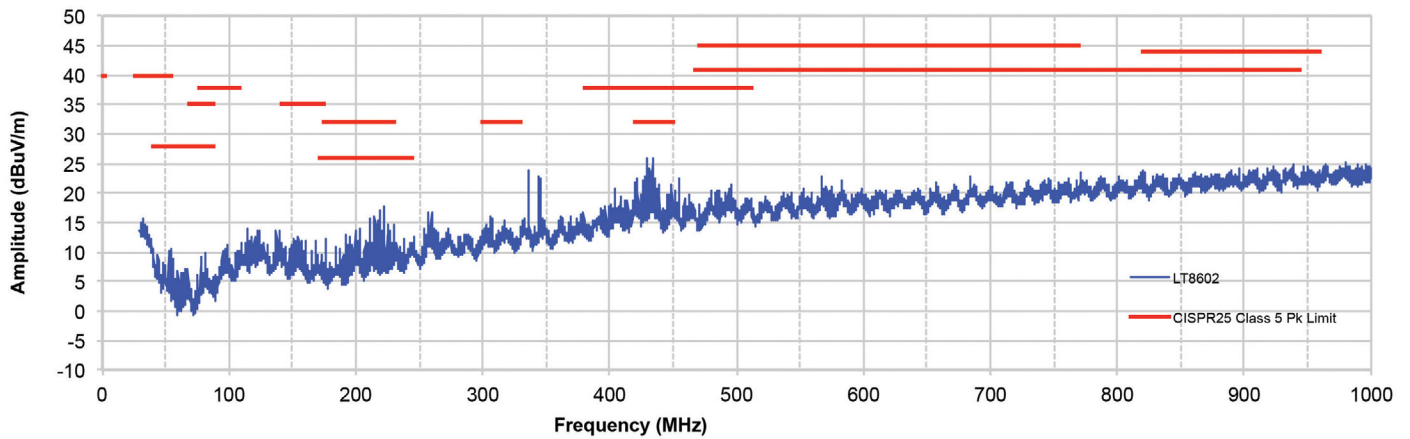
**TYPICAL PERFORMANCE CHARACTERISTICS**  $T_A = 25^\circ\text{C}$

Radiated EMI Performance, (CISPR25 Radiated Emission Tests with Class 5 Peak Limit)

**Vertical Polarization**



**Horizontal Polarization**



DC1949A Demo Board with EMI Filter Installed  $14V_{IN}$ , 1A at All Outputs,  $F_{SW} = 2\text{MHz}$

## PIN FUNCTIONS (QFN/LXE)

**BIAS (Pin 10/Pin 12):** Power to the internal  $INTV_{CC}$  regulator. Connect to an output  $\geq 3.1V$  when such a supply is available. Leaving BIAS unconnected will result in a decrease in efficiency at light load. Decouple to ground with a low ESR capacitor.

**BST1, BST2 (Pins 4, 5/Pins 6, 7):** Boost Voltage for HV Channels. The Boost Voltage provides a drive voltage higher than  $PV_{IN}$  to the gate of the NMOS top switch.

**CPOR (Pin 31/Pin 36):** Power-On Reset Timer. Connect a capacitor from this pin to ground to program the power-on reset timer. CPOR has a  $2\mu A$  pull-up current.

**EN/UVLO (Pin 22/Pin 26):** Enable/Undervoltage Lockout Input. The LT8602 is in low power shutdown when this pin is below  $0.4V$ . Between  $0.4V$  and  $1.1V$ , the part will turn on the internal reference. A precision threshold at  $1.2V$  (rising) enables the switching regulators. This allows the EN/UVLO pin to be used as an input undervoltage lockout by connecting to a resistor divider between  $V_{IN}$  and GND. When the EN/UVLO voltage is between  $0.4V$  and  $1.2V$ , the LT8602 input current will depend on the mode selected, the  $V_{IN}$  voltage and the EN/UVLO voltage. Connect to  $V_{IN}$  if the UVLO function is not needed.

**FB1, FB2 (Pins 26, 25/Pins 31, 29):** Feedback Input Pins for the High Voltage Converters. The converters regulate the corresponding feedback pin to the lesser of  $1V$  or the voltage on the associated TRKSS pin.

**FB3, FB4 (Pins 27, 24/Pins 32, 28):** Feedback Input Pins for the Low Voltage Converters. The converters regulate the corresponding feedback pin to  $800mV$ .

**GND (Pins 2, 8, 9, 13, 16, 35, 38, 41/Pins 2, 3, 10, 11, 15, 18, 20, 22, 30, 39, 41, 43, 46):** Ground. These pins must be soldered to PCB ground. The exposed pad (pin 41) must also be soldered to PCB ground.

**$INTV_{CC}$  (Pin 28/Pin 33):** Internal Regulator Bypass. Do not load the  $INTV_{CC}$  pin with external circuitry.  $INTV_{CC}$  is  $3.1V$  when  $BIAS < 3.1V$ ;  $3.4V$  when  $BIAS > 3.4V$ ; and equal to BIAS when BIAS is between  $3.1V$  and  $3.4V$ . Decouple to ground with a low ESR  $4.7\mu F$  capacitor.

**PG1, PG2 (Pins 1, 11/Pins 1, 13):** Power Good Indicators for Channels 1 and 2. Open drain logic output pulls down until the corresponding FB pin rises above  $0.92V$  but remains below  $1.08V$ .

**PG3, PG4 (Pins 40, 12/Pins 48, 14):** Power Good Indicators for Channels 3 and 4. Open drain logic output pulls down until the corresponding FB pin rises above  $0.736V$  but remains below  $0.864V$ .

**POREN (Pin 39/Pin 47):** Power On Reset Enable. This is a logic input that starts the ramp on the POR timing capacitor. This input has a weak pull-up.

**$PV_{IN1}$ ,  $PV_{IN2}$  (Pins 37, 14/Pins 44, 45, 16, 17):** Input Supply Voltage to HV Channels 1 and 2, respectively. These pins are independent and can be powered from different sources if necessary. Bypass each input with a low ESR capacitor to the adjacent GND pin.

**$PV_{IN3}$ ,  $PV_{IN4}$  (Pins 34, 17/Pins 40, 21):** Input Supply Voltage to low voltage Channels 3 and 4. These pins are typically connected to one of the high voltage converter outputs and should be locally bypassed with a low ESR capacitor.  $PV_{IN3}$  and  $PV_{IN4}$  are independent and do not need to be connected to the same supply voltage.

**$\overline{RST}$  (Pin 32/Pin 37):** Power-On Reset Output. CMOS output with weak pull-up, this pin is held low until the POR times out.

**RT (Pin 29/Pin 34):** Frequency Programming Resistor. Connect a resistor from this pin to ground to set the internal oscillator frequency.

## PIN FUNCTIONS (QFN/LXE)

**RUN3, RUN4 (Pins 30, 18/Pin 35, 23):** Run Inputs for the low voltage converters.

**SW1 (Pin 3/Pins 4, 5):** Channel 1 Switch Node. This is the output of the internal power switches for Channel 1.

**SW2 (Pins 6, 7/Pins 8, 9):** Channel 2 Switch Node. This is the output of the internal power switches for Channel 2. These pins must be connected together.

**SW3, SW4 (Pins 36, 15/Pins 42, 19):** Switch Nodes for low voltage converters. These are the outputs of the internal power switches for Channels 3 and 4.

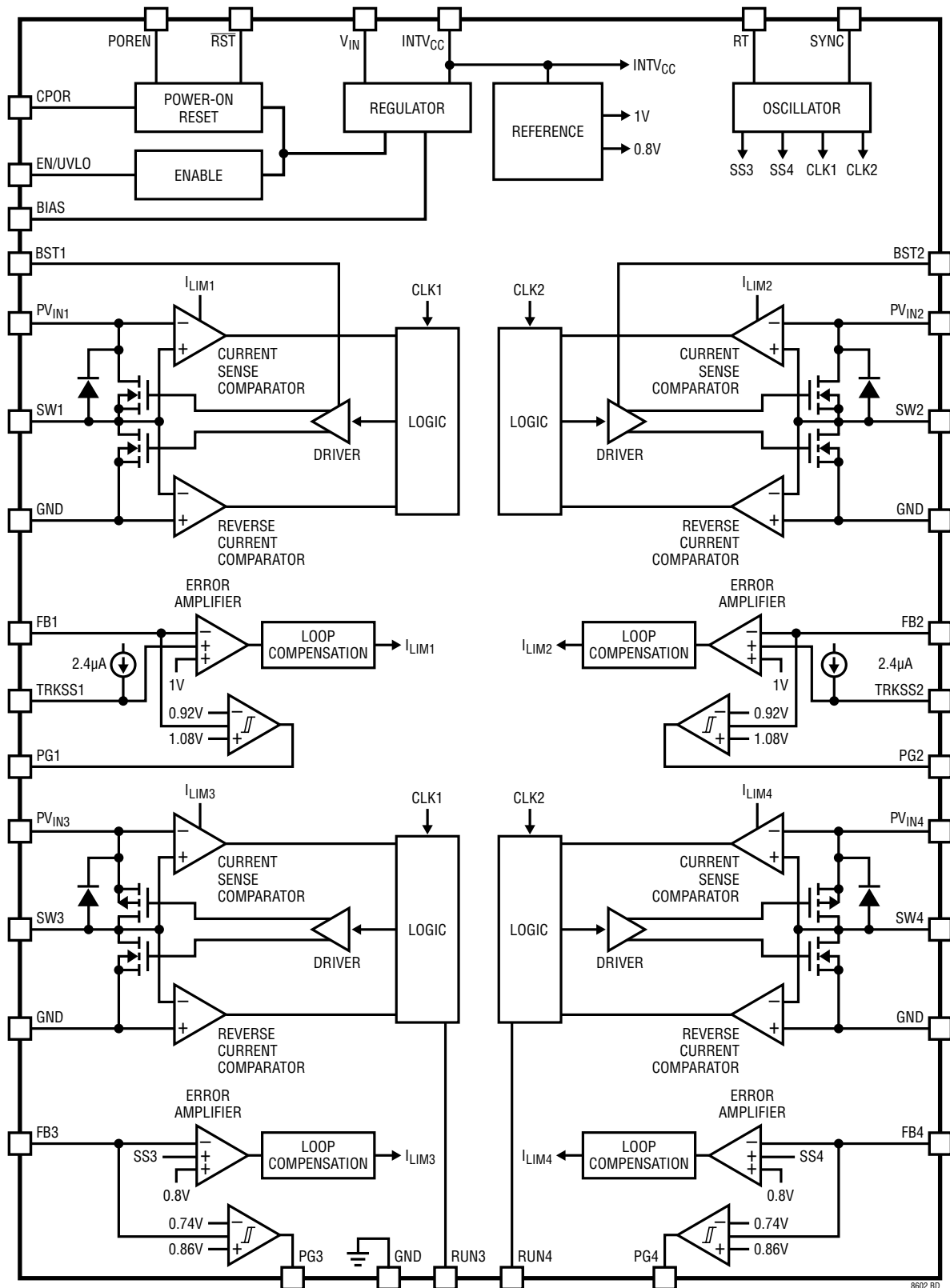
**SYNC (Pin 33/Pin 38):** Clock Synchronization Input. A digital input to allow the LT8602 to synchronize its switching

frequency to an external clock. If clock synchronization is not used, connect this pin to ground to enable low ripple burst mode or connect high to enable pulse skip operation of the synchronous converters. Do not allow SYNC to float.

**TRKSS1, TRKSS2 (Pins 21, 20/Pins 25, 24):** Track/Soft-Start Inputs for the High Voltage Converters. When this pin is below 1V, the converter regulates the FB pin to the TRKSS voltage instead of the internal reference. The TRKSS pin has a 2.4 $\mu$ A pull-up current. TRKSS may be left floating

**V<sub>IN</sub> (Pin 23/Pin 27):** Input Supply Voltage to Internal Functions. This pin is independent from any PV<sub>IN</sub> pin and can be powered from different sources if necessary. V<sub>IN</sub> must be above 3V for the part to operate.

# BLOCK DIAGRAM



## OPERATION

The LT8602 is a quad channel, constant frequency, current mode, monolithic buck switching regulator with power-on reset. All channels are synchronized to a single oscillator. Two of the channels are high voltage (up to 42V input) while the other two are low voltage (up to 5.5V input) and are typically powered from the high voltage buck outputs.

### Start-Up

When enabled by setting the EN/UVLO voltage above its threshold, the LT8602 starts charging the  $INTV_{CC}$  capacitor from  $V_{IN}$ . If BIAS is higher than 3.1V, BIAS supplies current to the  $INTV_{CC}$  regulator to reduce  $V_{IN}$  quiescent current.

### High Voltage Buck Regulators

Each high voltage channel is a synchronous buck regulator that operates from an independent  $PV_{IN}$  pin. The internal top power MOSFET is turned on at the beginning of each oscillator cycle, and turned off when the current flowing through the top MOSFET reaches a level determined by the error amplifier. The error amplifier measures the output voltage through an external resistor divider tied to the FB pin to control the peak current in the top switch. The reference of the error amplifier is determined by the lower of the internal 1V reference and the voltage at its TRKSS pin.

While the top MOSFET is off, the bottom MOSFET is turned on for the remainder of the oscillator cycle or until the inductor current starts to reverse. If overload conditions result in more than 2A (Ch 1) or 3.3A (Ch 2) flowing through the bottom switch, the next clock cycle will be delayed until switch current returns to a safe level.

### Low Voltage Buck Regulators

Each low voltage channel is a synchronous buck regulator that operates from an independent  $PV_{IN}$  pin. The  $PV_{IN}$  pins have an undervoltage lockout set at 2.35V. Each internal top power MOSFET is turned on at the beginning of each oscillator cycle, and turned off when the current flowing

through the top MOSFET reaches a level determined by the error amplifier. The error amplifier measures the output voltage through an external resistor divider tied to the FB pin to control the peak current in the top switch. The reference of the error amplifier is an internal 800mV reference. Each LV channel has a RUN pin to allow power sequencing and an internal soft-start circuit ramps the output voltage up in 1ms.

While the top MOSFET is off, the bottom MOSFET is turned on for the remainder of the oscillator cycle or until the inductor current starts to reverse. If overload conditions result in more than 2.4A flowing through the bottom switch, the next clock cycle will be delayed until switch current returns to a safe level.

### Multiphase Switching

The oscillator generates two clock signals 180° out of phase. Channels 1 and 3 operate on CLK1, while channels 2 and 4 operate on CLK2. Since a buck regulator only draws input current during the top switch on cycle, multiphase operation reduces peak input current and doubles the input current frequency. These effects reduce input current ripple and reduce the input capacitance required.

### Light Load Operation

At light load, the regulators operate in low ripple burst mode. Low ripple burst mode shuts down most internal circuitry between switch on cycles to conserve power while still retaining low ripple at the output.

### Undervoltage Lockout

The EN/UVLO pin is used to put the LT8602 in shutdown, reducing the input current to less than 1 $\mu$ A. The accurate 1.2V threshold of the EN/UVLO pin allows a programmable  $V_{IN}$  undervoltage lockout through an external resistor divider tied to the EN/UVLO pin. A 50mV (typ) hysteresis voltage on the EN/UVLO pin prevents switching noise from inadvertently shutting down the LT8602.

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## OPERATION

### Power Good Comparators

Each channel has a power good comparator that trips when the feedback pin is above or below its reference voltage by more than 8%. The PG output pins are open drain. The PG pin for each channel is pulled low when the corresponding output is out of regulation. The PG outputs are not valid until  $INTV_{CC}$  rises to 2.7V

### Power-On Reset Timer

The LT8602 includes a power-on reset timer. The power-on reset time is adjustable using an external capacitor on the CPOR pin. The timer is enabled by the POREN pin.

The  $\overline{RST}$  pin is the output of the POR timer and is an open-drain output with a weak internal pull-up. The  $\overline{RST}$  pin is valid when the LT8602 is enabled and  $INTV_{CC}$  is above 2.7V.

## APPLICATIONS INFORMATION

### Setting the Output Voltages

The output voltages are set by the resistor dividers on the outputs as shown in Figure 1. The formula used is:

$$R1 = R2 \cdot \left( \frac{V_{OUTx}}{FB_{REF}} - 1 \right)$$

where  $V_{OUTx}$  is the output voltage of regulator x and  $FB_{REF}$  is the feedback reference voltage.  $FB_{REF}$  is 1V for the high voltage regulators (1 and 2) and 800mV for the low voltage channels (3 and 4). Use 1% resistors in the dividers. R2 should be 200k or less to avoid noise problems.

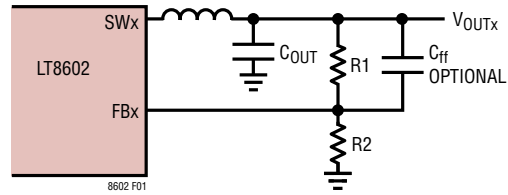
To improve the frequency response, a feedforward capacitor  $C_{ff}$  may be used. Typical values are 10pf to 100pf. Great care should be taken to route the  $V_{FB}$  node away from noise sources, such as the inductor or a SW line.

### Switching Frequency

The LT8602 uses a constant frequency architecture that can be programmed from 250kHz to 2.2MHz by tying a resistor from the  $R_T$  pin to ground. Table 1 shows the value of  $R_T$  for common switching frequencies.

**Table 1. Switching Frequency vs  $R_T$  Value**

SWITCHING FREQUENCY (MHz)	$R_T$ (k $\Omega$ )
0.25	254
0.35	179
0.5	124
0.75	81.2
1.0	60.4
1.25	47.6
1.5	39.4
1.75	33.3
2.0	28.9
2.2	26.3



**Figure 1. Feedback Resistor Divider**

The following equation approximates the values shown in Table 1:

$$R_T = \frac{61.9}{f_s - 0.009} - 1.9$$

where  $R_T$  is in k $\Omega$  and  $f_s$  is in MHz.

Selection of the operating frequency is mainly a trade-off between efficiency and component size. The advantage of high frequency operation is that smaller inductor and capacitor values may be used. The advantage of low frequency operation is higher efficiency.

The high switching frequency also decreases the duty cycle range because of finite minimum on- and off-times which are independent of the switching frequency. The top switch in the high voltage channel has a minimum on-time of 60ns and minimum off-time of 70ns. The top switch in the low voltage channel has a minimum on-time of 70ns and minimum off-time of 70ns. The minimum and maximum duty cycles are:

$$DC_{MIN} = f_s \cdot t_{ON(MIN)}$$

$$DC_{MAX} = 1 - f_s \cdot t_{OFF(MIN)}$$

where  $f_s$  is the switching frequency,  $t_{ON(MIN)}$  is the minimum switch on-time, and  $t_{OFF(MIN)}$  is the minimum switch off-time. These equations illustrate how duty cycle range increases when the switching frequency decreases.

The internal oscillator of the LT8602 can be synchronized to an external 250kHz to 2.2MHz clock signal on the SYNC pin.

## APPLICATIONS INFORMATION

### V<sub>IN</sub> Voltage Range

The LT8602's minimum operating voltage is 3V. To program a higher minimum operating voltage, use a resistor divider between the V<sub>IN</sub> pin and the EN/UVLO pin. The EN/UVLO threshold is 1.2V. The EN/UVLO pin has 50mV of hysteresis to prevent glitches from falsely disabling the LT8602.

The UVLO circuit is shown in Figure 3, Reverse Protection Diodes. The calculation for the lockout voltage is:

$$V_{IN(UVLO)} = \frac{R_{UV1} + R_{UV2}}{R_{UV2}} \cdot 1.2V$$

### PV<sub>IN</sub> Voltage Range

Each switching regulator channel operates from its own PV<sub>IN</sub> pin (PV<sub>IN1</sub> to PV<sub>IN4</sub>). The PV<sub>IN</sub> pin can be connected to either an independent voltage supply or a high voltage channel output. The PV<sub>IN1</sub> and PV<sub>IN2</sub> voltage range is 3.0V to 42V. The PV<sub>IN3</sub> and PV<sub>IN4</sub> voltage range is 2.6V to 5.5V.

The minimum PV<sub>IN</sub> voltage to regulate output voltage at full frequency is:

$$PV_{INx(MIN)} = \frac{V_{OUTx}}{DC_{MAX}}$$

Where DC<sub>MAX</sub> is the maximum duty cycle (refer to Switching Frequency section) for that channel. If PV<sub>IN</sub> is below the calculated minimum voltage, the channel starts to skip switch off cycles. At low input voltages the part will turn on the top switch for longer than a full switch cycle in order to extend the effective duty cycle. When the part is extending the effective duty cycle the switching frequency will drop to one half (or less) of the programmed frequency.

The maximum PV<sub>IN</sub> voltage to regulate output voltage at full frequency is:

$$PV_{INx(MAX)} = \frac{V_{OUTx}}{DC_{MIN}}$$

Where DC<sub>MIN</sub> is the minimum duty cycle (refer to Switching Frequency section) for that channel. If PV<sub>IN</sub> is above the

calculated maximum voltage, the channel starts to skip switch on cycles (pulse-skipping). In this case, the channel switching frequency will no longer be the programmed frequency. The output will continue to regulate, but the peak inductor current and output ripple will increase significantly.

### Inductor Selection

Inductor selection involves inductance, saturation current, series resistance (DCR) and magnetic loss.

A good starting point for the inductance values are:

$$L_X = K_X \cdot \frac{V_{OUTx}}{PV_{INx}} \cdot \frac{PV_{INx} - V_{OUTx}}{f_S}$$

where f<sub>S</sub> is the switching frequency in MHz, L<sub>x</sub> is in μH, V<sub>OUTx</sub> is the channel output voltage and K1 = 1.6, K2 = 1.0 and K3 and K4 = 1.3.

Once the inductance is selected, the inductor current ripple and peak current can be calculated:

$$\Delta I_{Lx} = \frac{V_{OUTx}}{Lx \cdot f_S} \cdot \left( 1 - \frac{V_{OUTx}}{PV_{INx(MAX)}} \right)$$

$$I_{Lx(PEAK)} = I_{OUTx(MAX)} + \frac{\Delta I_{Lx}}{2}$$

To guarantee sufficient output current, peak inductor current must be lower than the switch current limit (I<sub>LIM</sub>).

To keep the efficiency high, the inductor series resistance (DCR) should be as small as possible (must be <0.1Ω for channels 1, 3 and 4; <0.06Ω for channel 2), and the core material should be intended for the chosen switching frequency. Table 2 lists several vendors and suitable inductor series.

**Table 2. Inductor Vendors**

VENDOR	SERIES	WEBSITE
TDK	SLE, VLC, VLF	www.tdk.com
Sumida	CDRH, CDR, CDMC	www.sumida.com
Coilcraft	XAL, XFL, MSS	www.coilcraft.com
NIC	NPIM, NPIS	www.niccomp.com
Würth	TPC, SPC, PD, PDF, PD3	www.we-online.com

## APPLICATIONS INFORMATION

Of course, such a simple design guide will not always result in the optimum inductors for the applications. A larger value inductor provides a slightly higher maximum load current and will reduce the output voltage ripple. A larger value inductor can result in higher efficiency if the DCR and magnetic losses are the same. However, for inductors of the same dimensions, the larger value inductor has higher DCR. The trade-off between inductance and DCR is not always obvious. Use experiments to find optimum inductors.

Low inductance may result in discontinuous mode operation, which is acceptable, but reduces maximum load current. For details of maximum output current and discontinuous mode operation, see the Linear Technology Application Note 44. For duty cycles greater than 50%, there is a minimum inductance required to avoid subharmonic oscillations.

$$L_{\text{MINx}} = \frac{1.05 \cdot (V_{\text{OUTx}} + V_{\text{BOTx}})}{f_s}, \text{ chs 1, 3 and 4}$$

$$L_{\text{MINx}} = \frac{0.70 \cdot (V_{\text{OUTx}} + V_{\text{BOTx}})}{f_s}, \text{ ch 2}$$

where  $V_{\text{OUTx}}$  is the output voltage;  $V_{\text{BOTx}}$  is the voltage across the bottom switch;  $f_s$  is the switching frequency in MHz and  $L_{\text{MINx}}$  is in  $\mu\text{H}$ . If the frequency is synchronized over a range, use the lowest frequency to determine  $L_{\text{MINx}}$ .

### Shorted Output Protection

The LT8602 will tolerate a shorted output. If the bottom MOSFET current exceeds the valley current limit at the start of a clock cycle, the top MOSFET is kept off until the overcurrent situation clears. This prevents the buildup of inductor current during a shorted output.

### Input Capacitor Selection

Bypass each  $PV_{\text{IN}}$  pin of the LT8602 with a ceramic capacitor of X7R or X5R type.

Step-down converters draw current from the input supply in pulses with very fast rise and fall times. The input capacitor is required to reduce the resulting voltage ripple at the LT8602 input and to force this switching current into a tight local loop, minimizing EMI. The input capacitor must have low impedance at the switching frequency to do this effectively and it must have an adequate ripple current rating.

The worst case ripple current is when  $V_{\text{OUT}}$  is one half of  $PV_{\text{IN}}$ . In this case, the ripple current is:

$$I_{\text{CIN(RMS)}} = \frac{I_{\text{OUT}}}{2}$$

A reasonable value for the input capacitor is:

$$C_{\text{IN}} = \frac{4.7\mu\text{F (for Chs 1, 3, 4) or } 10\mu\text{F (for Ch 2)}}{f_s}$$

where  $f_s$  is the switching frequency in MHz.

Careful placement of  $C_{\text{IN}}$  is essential to get the lowest ripple and EMI.  $C_{\text{IN}}$  should be placed as close to the  $PV_{\text{IN}}$  pin as possible and on the same side of the PC board. The layer immediately below the component traces should be an unbroken ground plane. The ground side of  $C_{\text{IN}}$  should have at least 2 vias to the ground plane as close to  $C_{\text{IN}}$  as possible. This provides a high frequency return path directly under the  $PV_{\text{IN}}$  to  $C_{\text{IN}}$  trace. This minimizes loop area of the high frequency, high current path from  $PV_{\text{IN}}$  to  $C_{\text{IN}}$  and back to the GND exposed pad. See Figure 8, Recommended PCB Layout.

A word of caution is in order regarding the use of ceramic capacitors at the input. A ceramic input capacitor can combine with stray inductance to form a resonant tank circuit back to the supply. If power is applied quickly (for example by plugging the circuit into a live power source), this tank can ring, as much as doubling the input voltage. The solution is to either clamp the input voltage or dampen the tank circuit by adding a lossy capacitor in parallel with the ceramic capacitor. For details, see Linear Technology Application Note 88.

## APPLICATIONS INFORMATION

### Output Capacitor Selection

The output capacitor performs two functions. First, it filters the inductor current to generate an output with low voltage ripple. Second, it stores energy to minimize overshoot during transient loads. Because the LT8602 operates at a high frequency, minimal output capacitance is necessary. The control loop operates well with or without the presence of output capacitor series resistance (ESR). Ceramic capacitors, which achieve very low output ripple and small circuit size, are therefore an option.

You can estimate output ripple with the following equations:

$$V_{\text{RIPPLE}} = \frac{\Delta I_L}{8 \cdot f_S \cdot C_{\text{OUT}}}, \text{ for ceramic}$$

$$V_{\text{RIPPLE}} = \Delta I_L \cdot \text{ESR}, \text{ for aluminum or tantalum.}$$

where  $V_{\text{RIPPLE}}$  is the peak-to-peak output ripple,  $f_S$  is the switching frequency in MHz,  $\Delta I_L$  is the peak-to-peak ripple current in the inductor,  $C_{\text{OUT}}$  is the output capacitor value in  $\mu\text{F}$  and ESR is the output capacitor series resistance.

Another constraint on the output capacitor is that it must have greater energy storage than the inductor. When the load current steps from high to low, the stored energy in the inductor transfers to the output and the resulting voltage step should be small compared to the regulation voltage. For a 5% overshoot, this requirement indicates:

$$C_{\text{OUT}} \geq 10 \cdot L \cdot \left( \frac{I_{\text{LIM}}}{V_{\text{OUT}}} \right)^2$$

where  $I_{\text{LIM}}$  is the maximum switch current limit.

The low ESR and small size of ceramic capacitors make them the preferred type for LT8602 applications. Not all ceramic capacitors are the same, however. Many of the higher value capacitors use poor dielectrics with high temperature and voltage coefficients. In particular, Y5V and Z5U types lose a large fraction of their capacitance with applied voltage and at temperature extremes. Because loop stability and transient response depend on the value of  $C_{\text{OUT}}$ , this loss may be unacceptable. Use X7R or X5R types.

Electrolytic capacitors are also an option. The ESRs of most aluminum electrolytic capacitors are too large to deliver low output ripple. Tantalum, as well as newer, lower-ESR, organic electrolytic capacitors intended for power supply use are suitable. Choose a capacitor with a low enough ESR for the required output ripple. Because the volume of the capacitor determines its ESR, both the size and the value will be larger than a ceramic capacitor that would give similar ripple performance. One benefit is that the larger capacitance may give better transient response for large changes in load current. Table 3 lists several capacitor vendors.

**Table 3. Low ESR Capacitor Vendors**

VENDOR	SERIES	TYPE
Taiyo-Yuden www.t-yuden.com		Ceramic
TDK www.tdk.com		Ceramic
Kemet www.kemet.com	T494, T495 T510, T520, T525, T530 A700	Ceramic Tantalum Tantalum Organic Polymer Alum. Organic Polymer
Panasonic www.panasonic.com	SP-CAP	Ceramic Alum. Organic Polymer
AVX www.avx.com	TPS, TES, TCH	Ceramic Tantalum

### BST and SW Pin Considerations

The high voltage channels require a voltage above  $PV_{\text{IN}}$  to drive the gates of the top NFET switches. Connect an external capacitor between the BST and SW pins. An internal MOS switch connects BST to the internal  $\text{INTV}_{\text{CC}}$  supply during the switch off cycles. Then BST is boosted above SW during the switch on cycles. In most cases, a  $0.1 \mu\text{F}$  capacitor will work well.

### Soft-Start

The LT8602 has a soft-start pin for each high voltage channel and internal soft-start for each low voltage channel. The low voltage channel soft-start is set to 1ms.

On the high voltage channels, the feedback pin voltage is regulated to the lower of the corresponding TRKSS

## APPLICATIONS INFORMATION

pin and the internal reference of 1V. A capacitor from the TRKSS pin to ground is charged by an internal 2.4μA current source resulting in an output ramping linearly from 0V to the regulated voltage. The duration of the ramp is:

$$t_{SS} = C_{TRKSS} \cdot \frac{1V}{2.4\mu A}$$

where  $t_{SS}$  is the ramping time in seconds and  $C_{TRKSS}$  is the capacitance on the TRKSS pin in F.

The TRKSS pin is pulled down at start-up until  $INTV_{CC}$  has reached operating voltage. It is also pulled down in an undervoltage condition, either the internal lockout on  $PV_{IN}$  or the programmable EN/UVLO pin. The resistance when TRKSS is pulled down is 400Ω. Pulling TRKSS to ground does not guarantee the channel will stop switching.

The TRKSS pin can also be used to allow the output to track another regulator, either the other HV channel or an external regulator. Use a resistor divider from the controlling output to the TRKSS pin. Figure 2 shows the circuit for channel 2 tracking  $V_{OUT1}$  as well as output waveforms for coincident and ratiometric tracking.

R2 should be 10k or less to minimize the offset from the 2.4μA pull-up current.

Another easy method to ratiometrically track channels 1 and 2 is to tie both TRKSS1 and TRKSS2 together with a single capacitor to ground. This will double the soft-start current.

For applications with a start-up sequence that requires a PG pin be tied to a TRKSS input, a 10k or less resistor must be used as an external pull-up. The soft-start time with this configuration can be approximated by:

$$t_{SS} = 0.5 \cdot R_{PULLUP} \cdot C_{TRKSS}$$

A more exact formula, that includes the dependence on the pull-up voltage,  $V_{PULLUP}$ , is given by:

$$t_{SS} = -R_{PULLUP} \cdot C_{TRKSS} \cdot \log_e \left( 1 - \frac{1V}{V_{PULLUP}} \right)$$

### Reverse Protection

In battery charging applications or in battery backup systems, an output will be held high by the battery when the input to the LT8602 is absent. If the  $V_{IN}$  and  $PV_{IN}$  pins are floated and the LT8602 is enabled, the internal circuitry will pull its quiescent current through the SW pin of the output that is held high. This is acceptable if

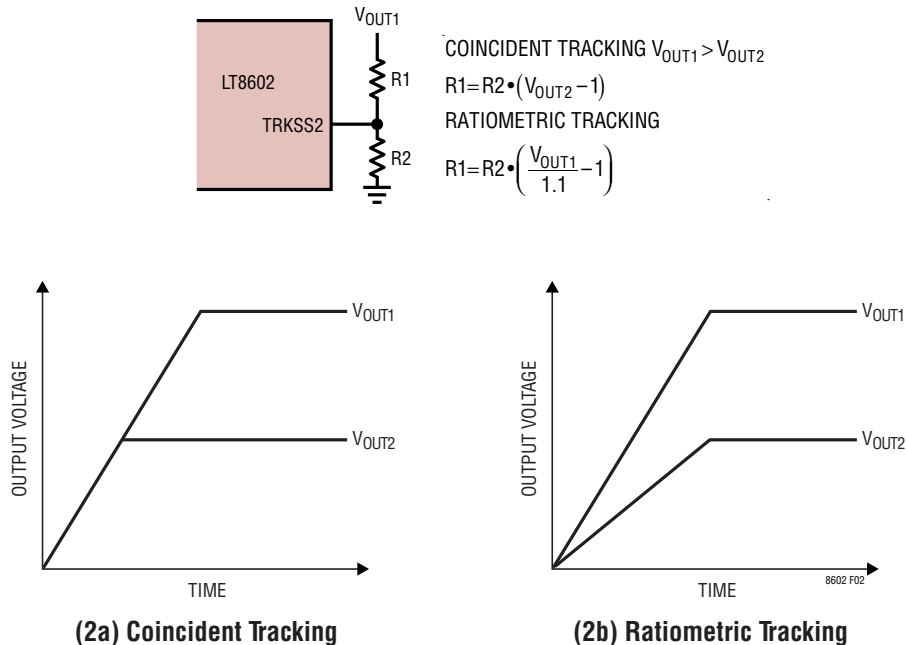


Figure 2. Tracking Circuit

## APPLICATIONS INFORMATION

the system can tolerate a small current ( $<100\mu\text{A}$ ) in this state. If the LT8602 is disabled, the SW pin current will drop to essentially zero. However, if the  $V_{\text{IN}}$  or  $PV_{\text{IN}}$  pin is grounded while the output is held high, an external diode is required at the  $V_{\text{IN}}/PV_{\text{IN}}$  pin to prevent current being pulled out of the  $V_{\text{IN}}/PV_{\text{IN}}$  pin. An example is shown in Figure 3. In this case, both OUT1 and OUT3 are held high by batteries.  $PV_{\text{IN}1}$  must be diode protected, as well as  $PV_{\text{IN}3}$  if it is connected to an external supply.

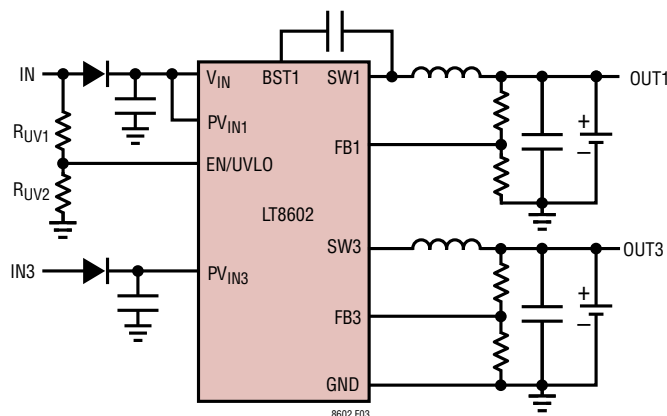


Figure 3. Reverse Protection Diodes

### Burst Mode Operation

To improve efficiency at light loads, the LT8602 automatically switches to Burst Mode operation which minimizes the switching loss and keeps the output voltage ripple small. In Burst Mode operation, most of the circuits are shut down between switch-on bursts to minimize power loss. If at least one channel remains full frequency, the oscillator remains on and all bursts are synchronized to the appropriate phase of the oscillator (Figure 4). If all

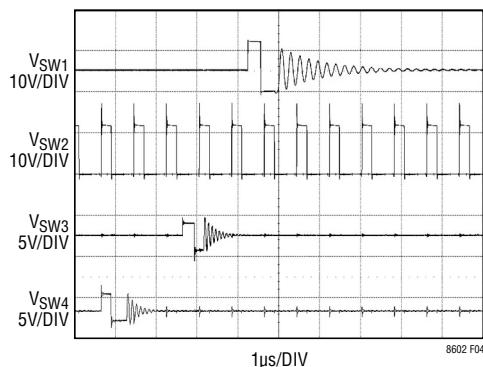


Figure 4. Burst Mode SW Waveforms with Oscillator Running

four channels go into Burst Mode operation, the oscillator will also shut off between bursts with a further savings in power (Figure 5). Because the channels of the LT8602 may have different loads, channels can have different switching frequencies when in Burst Mode operation.

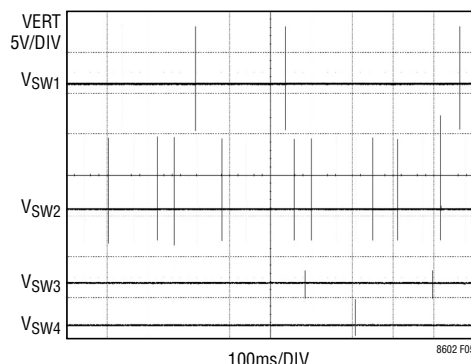


Figure 5. Burst Mode SW Waveforms with All Channels in Burst Mode

### Mode Selection and Synchronization

To select low ripple Burst Mode operation, tie the SYNC pin below 0.3V (this can be ground or a logic low output). To select pulse-skipping operation, tie the SYNC pin above 1.2V. To synchronize the LT8602 oscillator to an external frequency connect a square wave (with 20% to 80% duty cycle) to the SYNC pin. The square wave amplitude should have valleys that are below SYNC  $V_{\text{IL}}$  and peaks above SYNC  $V_{\text{IH}}$  (up to 6V).

The LT8602 will not enter Burst Mode operation at low output loads while synchronized to an external clock, but instead will pulse skip to maintain regulation. The LT8602 may be synchronized over a 250kHz to 2.2MHz range. The  $R_{\text{T}}$  resistor should be chosen to set the LT8602 switching frequency equal to the synchronization input. If a range of frequencies is used, set  $R_{\text{T}}$  to the center of the range. For example, if the synchronization signal will be 400kHz to 600kHz, the  $R_{\text{T}}$  should be selected for 500kHz. The SYNC lock range is  $\pm 20\%$  of the  $R_{\text{T}}$  set frequency.

For some applications it is desirable for the LT8602 to operate in pulse-skipping mode, offering two major differences from Burst Mode operation. First is that the clock stays awake at all times and all switching cycles are aligned to the clock. Second is that full switching frequency is

## APPLICATIONS INFORMATION

reached at lower output load than in Burst Mode operation. These two differences come at the expense of increased quiescent current. To enable pulse-skipping mode, the SYNC pin is tied high either to a logic output or to the INTV<sub>CC</sub> pin.

Do not leave the SYNC pin floating.

### Power Good Comparators

Each channel of the LT8602 has a power-good comparator that monitors the corresponding feedback voltages when the LT8602 is enabled. The threshold of power-good comparator is 0.92V to 1.08V for the high voltage channels, and 736mV to 864mV for the low voltage channels. The PG outputs are open-drain and require an external pull-up resistance value of 20k or less.

### Power-On Reset Timer

The power-on reset timer circuit provides a programmable reset timer. The POREN pin is the enable for the reset timer. The  $\overline{\text{RST}}$  output is an open-drain output with a weak internal pull-up (100k to ~2V). The weak pull-ups eliminate the need for external pull-ups when the rise time of these pins is not critical. The open-drain configuration allows wired-OR connections of the  $\overline{\text{RST}}$  pin.

The power-on reset timeout period,  $t_{\overline{\text{RST}}}$ , can be programmed by connecting a capacitor,  $C_{\text{POR}}$ , between the CPOR pin and ground. The value of  $t_{\overline{\text{RST}}}$  is calculated by:

$$t_{\overline{\text{RST}}} = 35.2 \cdot C_{\text{POR}}$$

Where  $C_{\text{POR}}$  is in pF and  $t_{\overline{\text{RST}}}$  is in microseconds. When POREN is enabled, the CPOR pin is ramped up at 2 $\mu$ A until it reaches 1.2V. The current reverses and ramps down at 20 $\mu$ A. When it reaches 0.2V, it ramps back up at 2 $\mu$ A. This cycle repeats a total of 64 times, then the RST pin is set high. For example, using a capacitor value of 8.2nF gives a 289ms reset timeout period. The accuracy of  $t_{\overline{\text{RST}}}$  will be limited by the accuracy and temperature coefficient of the capacitor  $C_{\text{POR}}$ . Extra parasitic capacitance on the CPOR pin, such as probe capacitance, can affect  $t_{\overline{\text{RST}}}$ . Figure 6 shows the power on reset timing. CPOR values above 10nF are not recommended.

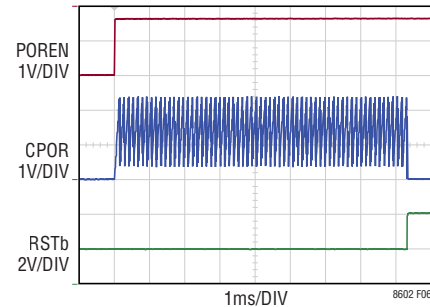


Figure 6. Power-On Reset Timing  $C_{\text{POR}} = 230\text{pF}$

### Sequencing

The LT8602 provides great flexibility in sequencing the 4 channels and the power-on reset timer. Each channel has a power good output (PG1 to PG4) and a controlling input (TRKSS1 and 2, RUN3 and 4). The POR has a control input (POREN) and a reset output ( $\overline{\text{RST}}$ ). All 5 outputs are open-drain. All 5 inputs are active high and 3 of them (TRKSS1 and 2, POREN) have internal pull-up currents to reduce external component counts. The soft-start function on the TRKSS pins will work when using sequencing; simply connect the capacitor to the TRKSS pin, connect an external pull-up resistor of value 10k or less and use the desired PG output to short the cap. A sequencing example is shown in Figure 7.

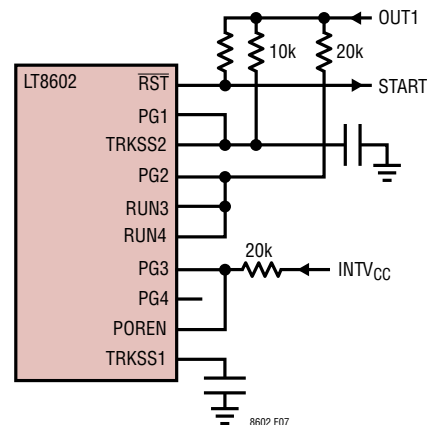


Figure 7. Sequencing the Outputs and POR

## APPLICATIONS INFORMATION

In this example, channel 1 starts first, and soft-starts according to the cap on TRKSS1. Once OUT1 has reached regulation, channel 2 soft-starts. When OUT2 is good, channels 3 and 4 start up. When OUT3 is in regulation, then the POR is started. One caution when connecting RUN pins to TRKSS pins: the TRKSS channel will start ramping immediately, but the RUN channel will not start until the voltage reaches the RUN threshold.

The EN/UVLO pin has two thresholds enabling three modes (see Figure 8: EN/UVLO Thresholds). When EN/UVLO is below the shutdown threshold, the 8602 is in low power shutdown and draws less than  $1\mu\text{A}$  from  $V_{\text{IN}}$  under all conditions. The shutdown threshold is between 0.4V and 1.1V. Once EN/UVLO has risen above the shutdown threshold but is still below the undervoltage threshold, the internal bias circuits start up but the switching regulators are kept off. The input current in this region can be as high as  $400\mu\text{A}$ , depending on the mode selected,  $V_{\text{IN}}$  and direction of EN/UVLO. Since the internal reference is now on, it establishes an accurate undervoltage threshold of 1.2V (typ). When EN/UVLO rises above the undervoltage threshold, then the switching regulators are turned on and normal operation begins. This allows a programmable undervoltage lockout by connecting a resistor divider from EN/UVLO to  $V_{\text{IN}}$ .

If the EN/UVLO function is not needed, the pin can be connected directly to  $V_{\text{IN}}$ . If only enable is needed and the undervoltage lockout is not needed, the EN/UVLO pin can be connected directly to a logic output with a  $V_{\text{OH}}$  of at least 1.25V and a  $V_{\text{OL}}$  less than 0.4V.

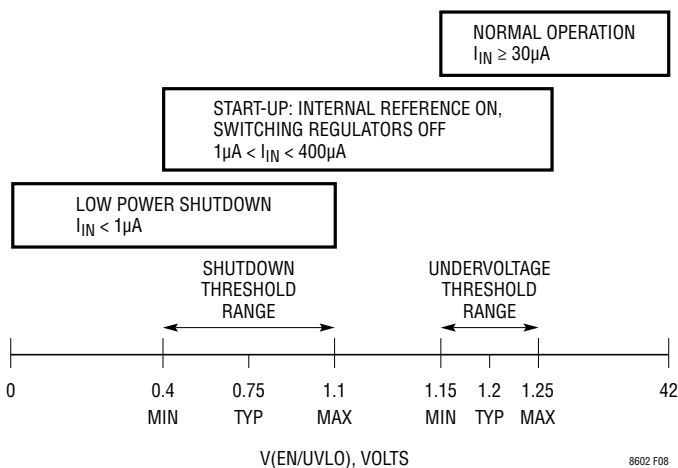


Figure 8. EN/UVLO Thresholds

## PCB Layout

For proper operation and minimum EMI, care must be taken during printed circuit board layout. Figure 9 shows the recommended component placement with trace, ground plane and via locations. Note that large, switched currents flow in the LT8602's  $PV_{\text{IN}}$  pins, GND pins, and the input capacitors. The loop formed by the input capacitor should be as small as possible by placing the capacitor close to the  $PV_{\text{IN}}$  pin and the adjacent GND pin. When using a physically large input capacitor the resulting loop may become too large in which case using a small case/value capacitor placed close to the  $PV_{\text{IN}}$  and GND pins plus a larger capacitor further away is preferred. These components, along with the inductor and output capacitor, should be placed on the same side of the circuit board, and their connections should be made on that layer. Place a local, unbroken ground plane under the application circuit on the layer closest to the surface layer. The SW and BOOST nodes should be as small as possible. Finally, keep the FB and RT nodes small so that the ground traces will shield them from the SW and BOOST nodes. The exposed pad on the bottom of the package must be soldered to ground so that there is a good electrical connection as well as a good thermal connection so that the PCB can act as a heat sink. To keep thermal resistance low, extend the ground plane as much as possible, and add thermal vias under

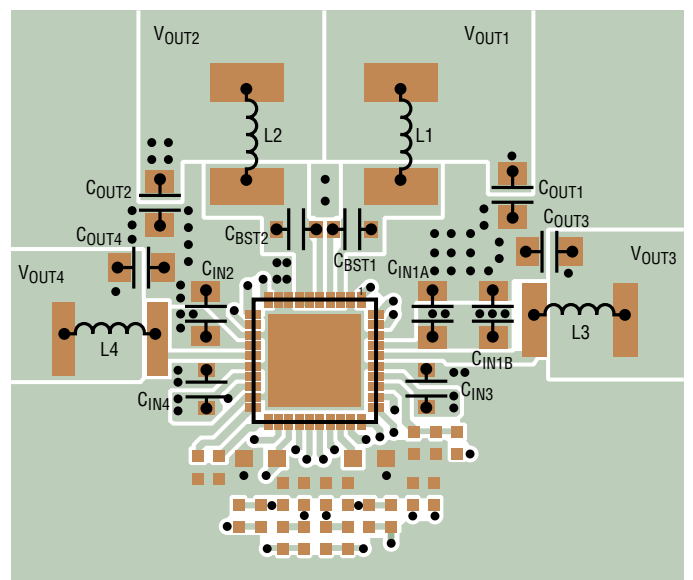


Figure 9. Recommended QFN Package PCB Layout

## APPLICATIONS INFORMATION

and near the LT8602 to additional ground planes within the circuit board and on the bottom side.

### Thermal Considerations

Care should be taken in the layout of the PCB to ensure good heat sinking of the LT8602. The exposed pad on the bottom of the package must be soldered to a ground plane. This ground should be tied to large copper layers below with thermal vias; these layers will spread heat dissipated by the LT8602. Recommended layer use for a 4 layer board is:

Layer 1 (Components): use 2oz copper; unbroken high frequency/high current routing ( $C_{IN}$  loop, SW node, BST node, inductor,  $C_{OUT}$ ), high current DC routing, ground plane on remainder

Layer 2 (Internal): Unbroken ground plane

Layer 3 (Internal): Signal routing, ground plane on remainder

Layer 4 (Bottom): Use 2oz copper; high current DC routing ( $V_{IN}$ ,  $V_{OUT}$ ), ground plane on remainder

Placing additional vias can reduce thermal resistance further. Many small thermal vias are better than a few large ones. Following these PCB design guidelines can reduce the QFN  $\theta_{JA}$  to 22°C/W.

Power dissipation within the LT8602 can be estimated by adding the power dissipated in each channel. Calculate each channel's power loss from an efficiency measurement and subtract the inductor loss. The die temperature is calculated by multiplying the total LT8602 power dis-

sipation by the thermal resistance from junction to ambient and adding the ambient temperature. The maximum load current should be derated as the die temperature approaches the maximum junction rating. The LT8602 will stop switching if the internal temperature rises too high. This thermal protection is above the maximum operating temperature and is intended as a failsafe only.

Even with the best thermal practices, the LT8602 must be derated at high ambient temperature. The thermal derating curves in Figure 10 show the front page application (Ch1: 5V<sub>OUT</sub>, Ch 2: 3.3V<sub>OUT</sub>, Ch 3: 1.8V<sub>OUT</sub>, Ch 4: 1.2V<sub>OUT</sub>). The PCB layout is as described above and the  $\theta_{JA}$  is 22°C/W. The output currents are decreased uniformly as a percentage of maximum. Although derating is application dependent, this set of curves is representative of typical applications with a range of frequencies and input voltages.

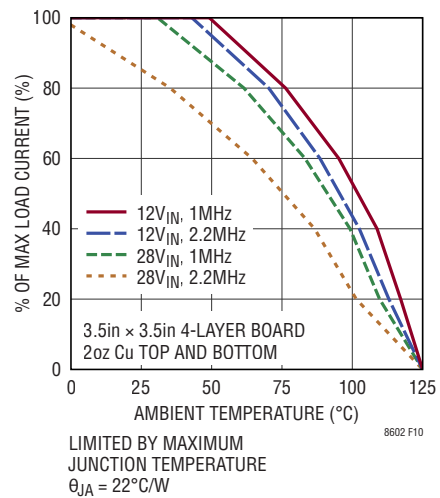
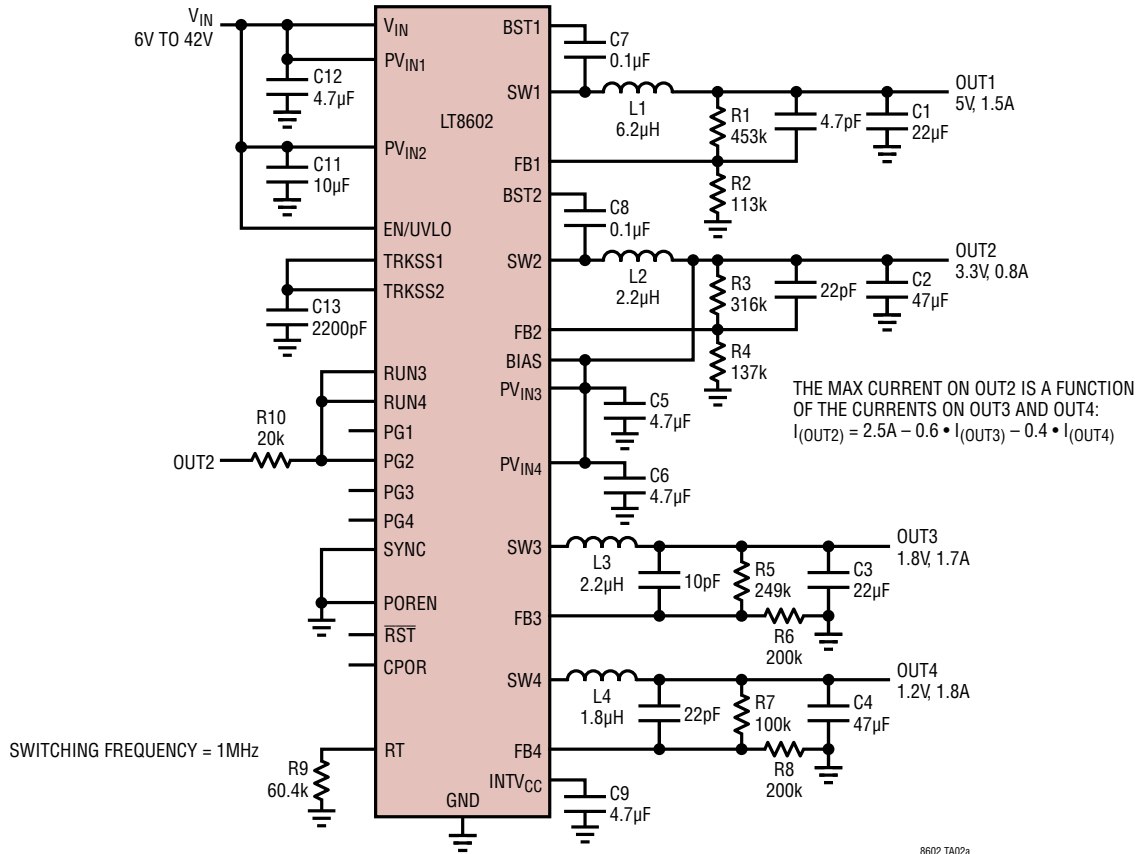


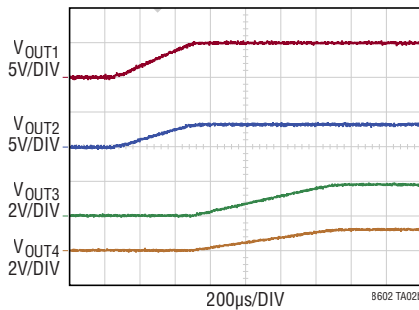
Figure 10. Thermal Derating, I-Grade

TYPICAL APPLICATIONS

Details of Front Page Application



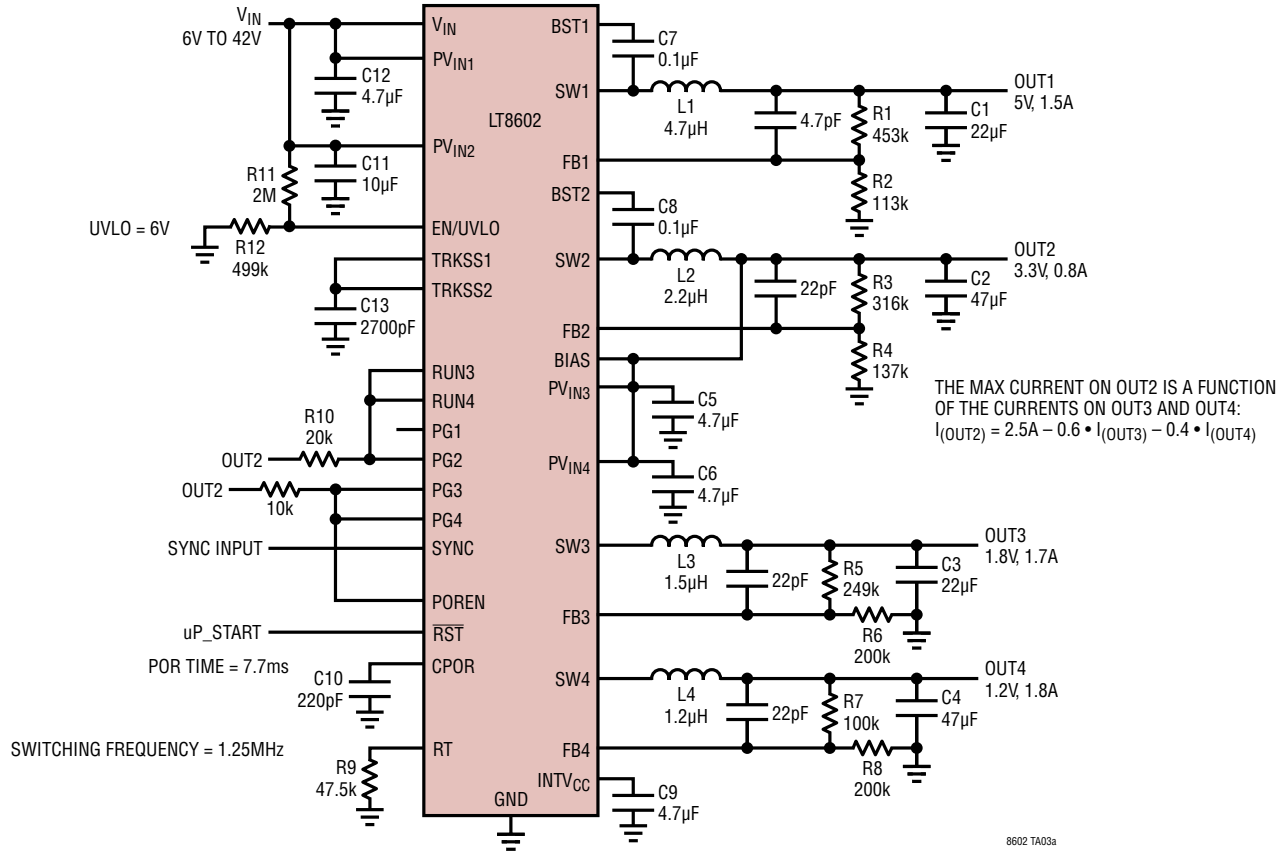
Start-Up Sequence



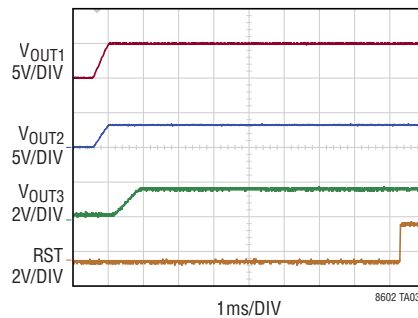
THE VALUES SHOWN ARE FOR 1MHz OPERATION.  
 FOR 2MHz OPERATION, MAKE THE FOLLOWING CHANGES:  
 $L1 = 3.3\mu H$   
 $L2 = 1.2\mu H$   
 $L3 = 1.2\mu H$   
 $L4 = 1\mu H$   
 $R9 = 28.9k$   
 THE INPUT VOLTAGE RANGE AT 2MHz IS 6V TO 24V.  
 ABOVE 24V, THE HV CHANNELS WILL REGULATE  
 BUT WITH HIGH RIPPLE DUE TO MISSED PULSES.

TYPICAL APPLICATIONS

Automotive Input Steps Down to 5V, 3.3V, 1.8V and 1.2V



Start-Up Sequence

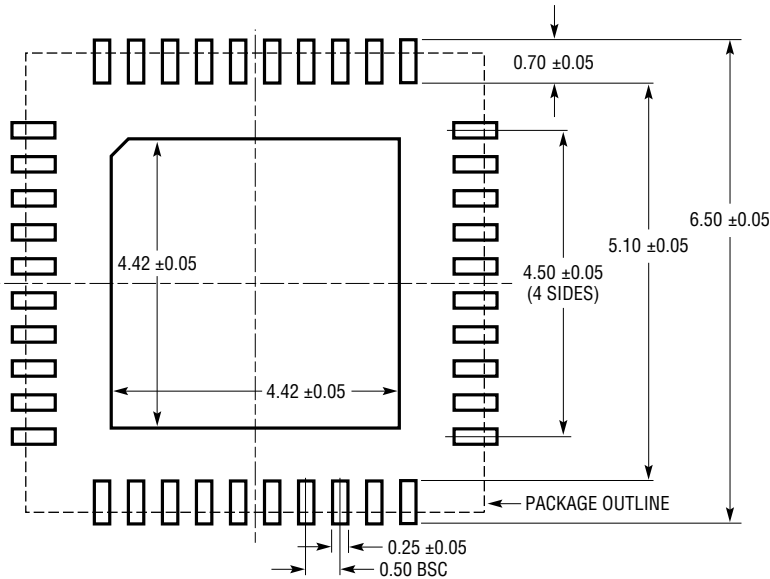


START-UP SEQUENCE:  
 CH1 AND CH2 SOFT-START  
 RATIOMETRICALLY;  
 THEN CH3 AND CH4 TURN ON;  
 THEN POR TIMER STARTS.

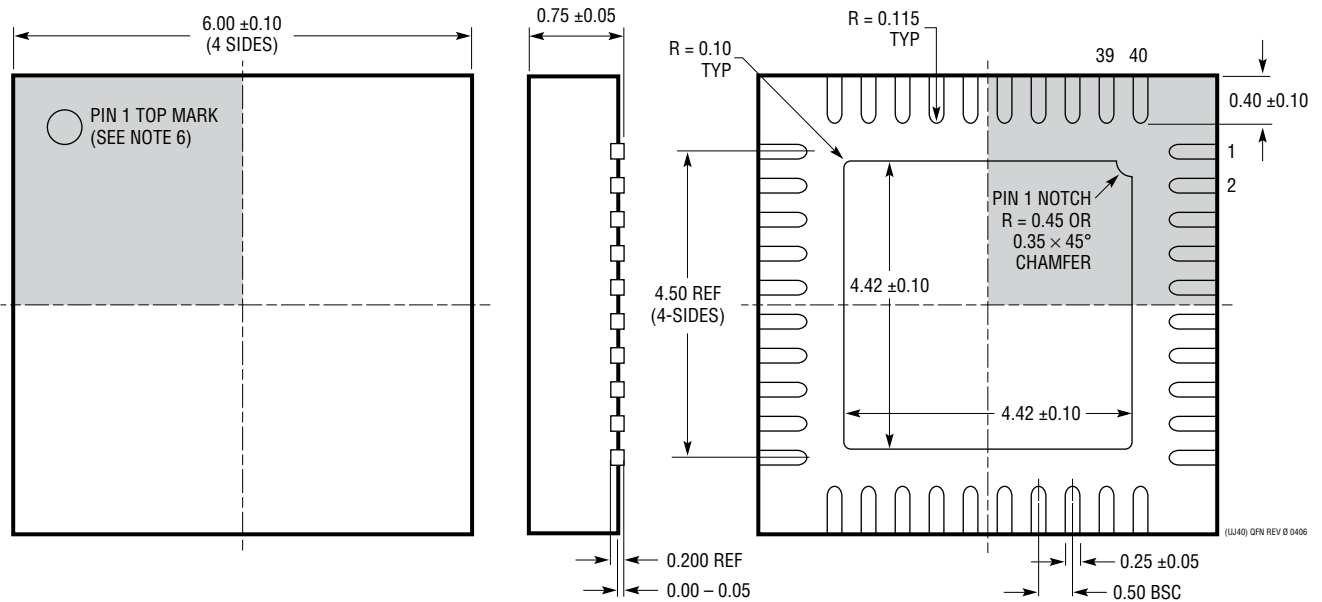
# PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/product/LT8602#packaging> for the most recent package drawings.

**UJ Package**  
**40-Lead Plastic QFN (6mm × 6mm)**  
 (Reference LTC DWG # 05-08-1728 Rev 0)



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS  
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



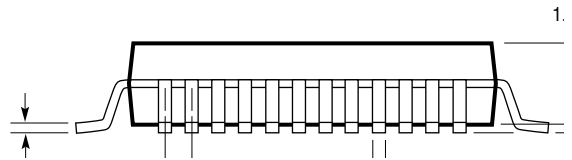
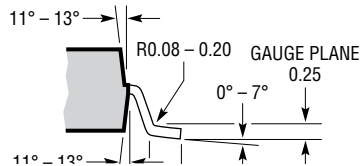
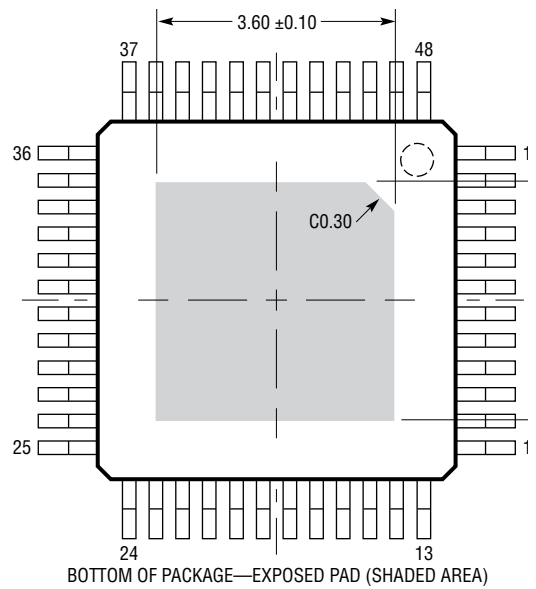
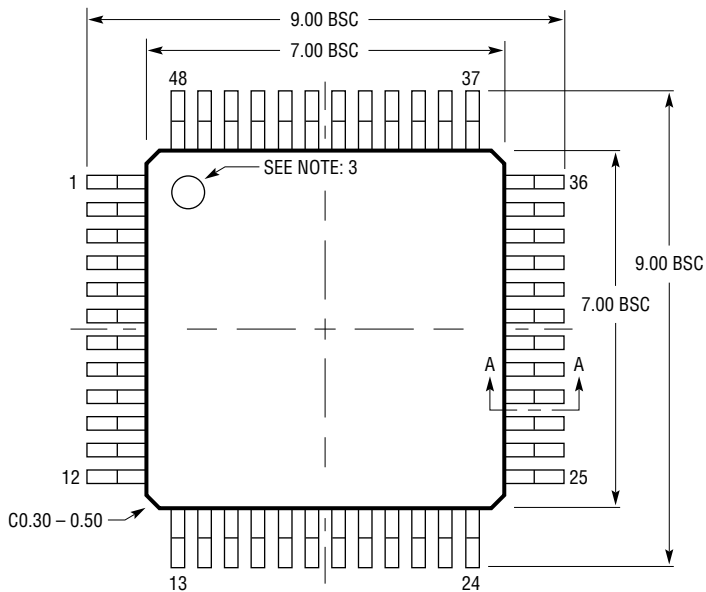
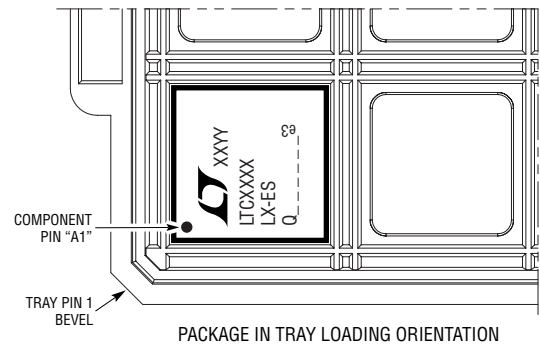
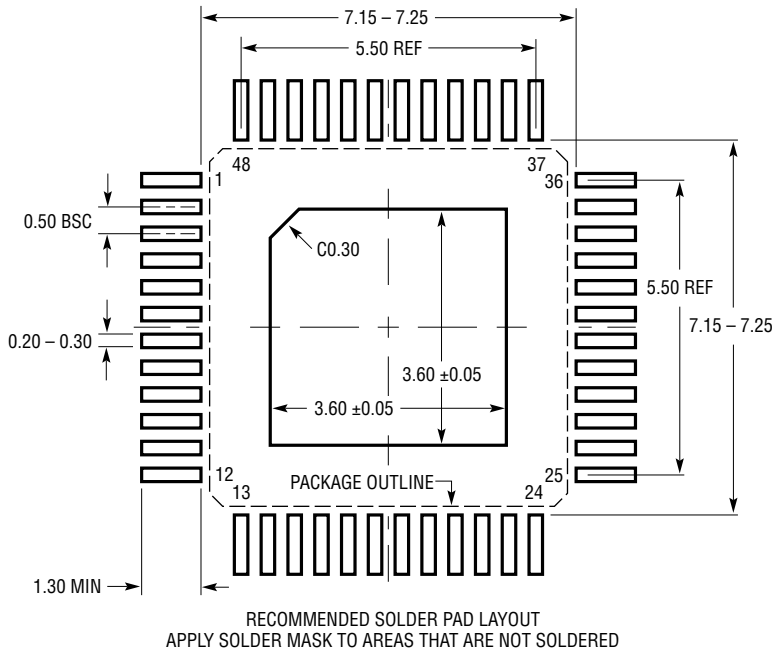
- NOTE:
1. DRAWING IS A JEDEC PACKAGE OUTLINE VARIATION OF (WJJD-2)
  2. DRAWING NOT TO SCALE
  3. ALL DIMENSIONS ARE IN MILLIMETERS
  4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.20mm ON ANY SIDE, IF PRESENT
  5. EXPOSED PAD SHALL BE SOLDER PLATED
  6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

BOTTOM VIEW—EXPOSED PAD

# PACKAGE DESCRIPTION

Please refer to <http://www.linear.com/product/LT8602#packaging> for the most recent package drawings.

## LXE Package 48-Lead Plastic Exposed Pad LQFP (7mm × 7mm) (Reference LTC DWG #05-08-1832 Rev D)

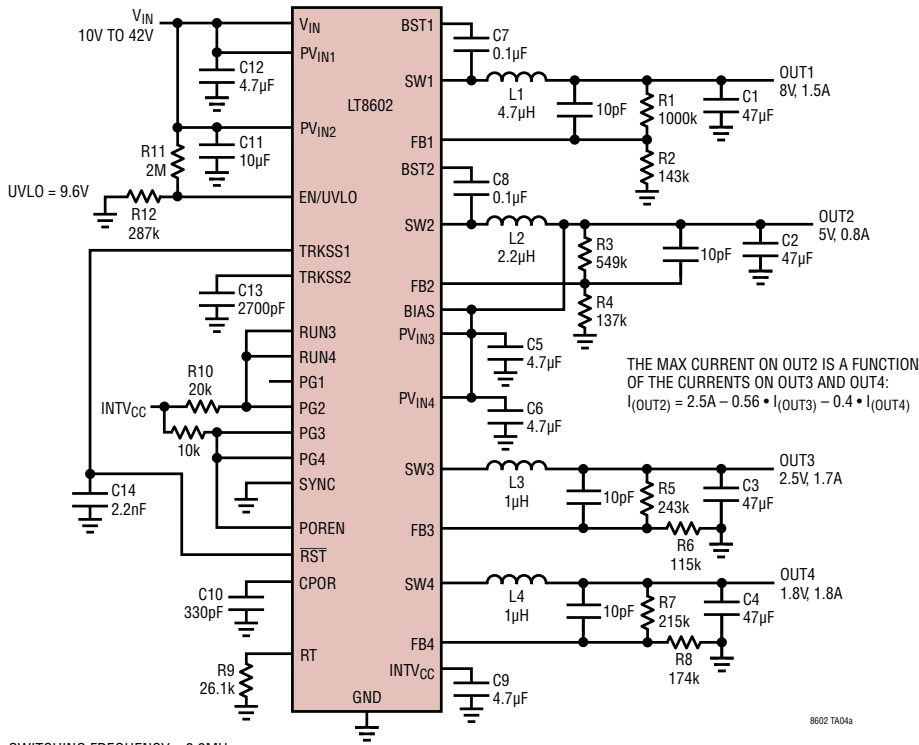


## REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	09/16	Revised Electrical Characteristics tables and temperature dotted soft-start.	4, 5
		Replaced G06 and G07 curves.	6
		Revised Pin Functions for BIAS, EN/UVLO INTV <sub>CC</sub> .	11
		Changed Figure 7.	20
B	06/17	Added LQFP package option	1,2
		Added Pin Functions for LQFP package option	11,12
		Clarified Figure 9 for QFN package	22
		Added clarified drawing for front page application	25
		Typical Application moved from page 25 to 26	26
		Clarified QFN package drawing	27
		Added LQFP package option	28

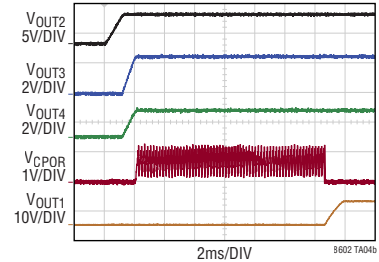
## TYPICAL APPLICATION

10V to 42V Input Steps Down to 5V, 2.5V, 1.8V and 8V (Delayed)



SWITCHING FREQUENCY = 2.2MHz

Start-Up Sequence



IN THIS APPLICATION, THE POR IS USED AS A DELAY FOR THE 8V SUPPLY. THE 8V SUPPLY WILL START RAMPING UP 12ms AFTER ALL OTHER SUPPLIES HAVE REACHED REGULATION.

START-UP SEQUENCE:  
 CH2 SOFT-STARTS;  
 THEN CH3 AND CH4 TURN ON;  
 THEN POR TIMER STARTS;  
 AFTER POR TIMES OUT, THEN CH1 SOFT-STARTS.

## RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
<a href="#">LT3507/</a> <a href="#">LT3507A</a>	36V, 2.7A + 1.8A + 1.8A + LDO Controller, 2.5MHz, High Efficiency, Triple Output Step-Down DC/DC Converter	$V_{IN} = 4V$ to 36V, $V_{OUT(MIN)} = 0.8V$ , $I_Q = 7mA$ , $I_{SD} < 1\mu A$ , 5mm x 7mm QFN
<a href="#">LT8640</a>	42V, 6A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , 3mm x 4mm QFN
<a href="#">LT8616</a>	42V Dual (2.5A + 1.5A), 95% Efficiency 3MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 6.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.8V$ , $I_Q = 6.5\mu A$ , $I_{SD} < 1\mu A$ , TSSOP-28E Package
<a href="#">LT8614</a>	42V, 4A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , 3mm x 4mm QFN
<a href="#">LT8612</a>	42V, 6A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , 3mm x 6mm QFN
<a href="#">LT8610</a>	42V, 2.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , MSOP-16E
<a href="#">LT8611</a>	42V, 2.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$ and Input/Output Current Limit/Monitor	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , 3mm x 5mm QFN-24
<a href="#">LT8610A/</a> <a href="#">LT8610AB</a>	42V, 3.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with $I_Q = 2.5\mu A$	$V_{IN} = 3.4V$ to 42V, $V_{OUT(MIN)} = 0.985V$ , $I_Q = 2.5\mu A$ , $I_{SD} < 1\mu A$ , MSOP-16E

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